



THOMSON

VIDEO 

SERVICE MANUAL
DOCUMENTATION TECHNIQUE
TECHNISCHE DOKUMENTATION
DOCUMENTAZIONE TECNICA
DOCUMENTACION TECNICA

DTH7500



DTH7500E
DTH7500U



WARNING : *Before servicing this chassis please read the safety recommendations.*
ATTENTION : *Avant toute intervention sur ce châssis, lire les recommandations de sécurité.*
ACHTUNG : *Vor jedem Eingriff auf diesem Chassis, die Sicherheitsvorschriften lesen.*
ATTENZIONE : *Prima di intervenire sullo chassis, leggere le norme di sicurezza.*
IMPORTANTE : *Antes de cualquier intervención, leer las recomendaciones de seguridad.*

Code : 357 275 80 - 0204 / 4,8M - DTH7500 Print.



Do not disconnect modules when they are energized!
Repairs on power supply section are to be carried out only with isolating transformer.

Ne pas retirer les modules lorsqu'ils sont sous tension. N'effectuer les travaux de maintenance sur la partie reliée au secteur (Switch Mode) qu'au travers d'un transformateur d'isolement.

Module nicht bei eingeschaltetem Gerät entfernen!
Servicearbeiten am Netzteil nur unter Verwendung eines Regeltrenntrafos durchführen.

Non scollegare le piastre quando sono alimentate!
Per le riparazioni sulla sezione alimentatore, utilizzare un trasformatore isolatore.

No desconectar los módulos cuando están activados. Las reparaciones en la sección de alimentación de energía deben ser ejecutadas solamente con un transformador de separación.

Indicates critical safety components, and identical components should be used for replacement. Only then can the operational safety be guaranteed.

Le remplacement des éléments de sécurité (repérés avec le symbole) par des composants non homologués selon la Norme CEI 65 entraîne la non-conformité de l'appareil. Dans ce cas, la responsabilité du fabricant n'est plus engagée.

Wenn Sicherheitsteile (mit dem Symbol) gekennzeichnet nicht durch Original - Ersatzteile ersetzt werden, erlischt die Haftung des Herstellers.

La sostituzione dei componenti di sicurezza (evidenziati con il segno) con componenti non omologati secondo la norma CEI 65 comporta la non conformità dell'apparecchio. In tal caso è "esclusa la responsabilità" del costruttore.

La sustitución de elementos de seguridad (marcados con el símbolo) por componentes no homologados según la norma CEI 65, provoca la no conformidad del aparato. En ese caso, el fabricante cesa de ser responsable.

MEASUREMENT CONDITIONS - CONDITIONS DE MESURES - MESSBEDINGUNGEN CONDIZIONI DI MISURA - CONDICIONES DE MEDIDAS

RECEIVER :

On UHF input level : 1 mV, bar test pattern :
- PAL, I standard, 100% white.

Via the scart socket, input level : 1 Vpp, bar test pattern :

Colour, contrast and brightness at mid-position, sound at minimum.
Programme selected : PR 01.

DC voltages measured between the point and earth using a digital voltmeter.

RICEVITORE :

In UHF, livello d'entrata 1 mV, monoscopio barre :
- PAL, norma G. bianco 100%.

Via SCART, livello d'entrata 1 Vpp, monoscopio barre :

Colore, Contrasto, Luminosità media, Suono minimo.
Programma selezionato PR 01.

Tensioni continue rilevate rispetto alla massa con un voltmetro digitale.

RECEPTEUR :

En UHF, niveau d'entrée 1 mV mire de barres
- SECAM, Norm L, Blanc 100%.

Par la prise Péritélévision, niveau d'entrée 1 Vcc, mire de barres .

Couleur, contraste, lumière à mi-course, son minimum.
Programme affecté PR 01.

Tensions continues relevées par rapport à la masse avec un voltmètre numérique.

EMPFÄNGER :

Bei UHF Eingangsspegel 1 mV, Farbbalken :
- PAL, Norm G, Weiss 100%.

Über die Scartbuchse : Eingangsspegel 1 Vss, Farbbalken :

Farbe, Kontrast, Helligkeit in der Mitte des Bereichs, Ton auf Minimum.
Zugeordnetes Programm PR 01.

Gleichspannungen mit einem digitalen Voltmeter zur Masse gemessen.

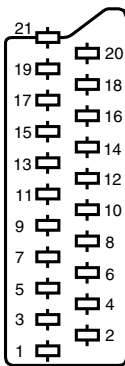
RECEPTOR :

En UHF, nivel de entrada 1 mV, mira de barras :
- PAL, norma G, blanco 100%.

Por la toma Peritelevision, nivel de entrada 1 Vpp mira de barra.

Color, Contraste, luz a mitad de carrera, Sonido mínimo.
Programa afectado PR 01.

Tensiones continuas marcadas en relación a la masa con un voltmetro digital.



NOTE : **(MAIN)** ... etc. identifies each pcb module.

NOTE : **(MAIN)** ... etc. repères des platines constituant l'appareil.

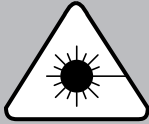
HINWEIS : **(MAIN)** ... usw. Kennzeichnung der Platinen, aus denen das Gerät zusammengesetzt ist.

NOTA : **(MAIN)** ... ecc. sigla delle piastre dell'apparecchio.

NOTA : **(MAIN)** ... etc. marcas de las placas que constituyen el aparato.

	ENGLISH	FRAÇAIS	DEUTSCH	ITALIANO	ESPAÑOL
1	AUDIO "R"	AUDIO "D"	AUDIO "R"	AUDIO "D"	AUDIO "D"
2	AUDIO "R"	AUDIO "D"	AUDIO "R"	AUDIO "D"	AUDIO "D"
3	AUDIO "L"	AUDIO "G"	AUDIO "L"	AUDIO "S"	AUDIO "I"
4	AUDIO	AUDIO	AUDIO	AUDIO	AUDIO
5	"BLUE"	"BLEU"	"BLAU"	"BLU"	"AZUL"
6	AUDIO "L" MONO	AUDIO "G" MONO	AUDIO "L" MONO	AUDIO "S" MONO	AUDIO "I" MONO
7	"BLUE"	"BLEU"	"BLAU"	BLU	AZUL
8	SLOW SWITCH	COMMUT. LENTE	AV UMSCHALTUNG	"COMMUTAZIONE LENTA"	"CONMUTACION LENTA"
9	"GREEN"	"VERT"	"GRÜN"	"VERDE"	"VERDE"
10	AV LINK	AV LINK	AV LINK	AV LINK	AV LINK
11	"GREEN"	"VERT"	"GRÜN"	"VERDE"	"VERDE"
12 NC					
13	"RED"	"ROUGE"	"ROT"	"ROSSO"	"ROJA"
14 NC					
15	"RED"	"ROUGE"	"ROT"	"ROSSO"	"ROJA"
16	FAST SWITCH	COMMUT. RAPIDE	AUSTASTUNG	"COMMUTAZIONE RAPIDA"	"CONMUTACION RAPIDA"
17	VIDEO	VIDEO	VIDEO	VIDEO	VIDEO
18	FAST SWITCH	COMMUT. RAPIDE	AUSTASTUNG	"COMMUTAZIONE RAPIDA"	"CONMUTACION RAPIDA"
19	VIDEO	VIDEO	VIDEO	VIDEO	VIDEO
20	VIDEO OR "SYNC"	VIDEO SYNCHRO	VIDEO ODER SYNCHRO	VIDEO O SINCRO	VIDEO O SINCRO
21	PLUG SCREEN BOX	BLINDAGE PRISE	ABSCHIRMUNG DES STECKERS	INVOLUCRO METALLICO DELLA PRESA	BLINDAJE DEL ENCHUFE


: INPUT - ENTRÉE - EINGANG - ENTRATA - ENTRADA • : OUTPUT - SORTIE - AUSGANG - USCITA - SALIDA • : EARTH - MASSE - MASSE - MASSA - MASA




CLASS 2 LASER PRODUCT
APPAREIL A LASER DE CLASSE 2
LASER KLASSE 2
APPARECCHIO CON LASER DI CLASSE 2
APARATO CON LASER DE CLASE 2

DANGER :	Invisible laser radiation when open and interlock failed or defeated. Avoid direct exposure to beam.
ATTENTION :	Le rayon laser est invisible. Eviter l'exposition directe lors de la maintenance.
VORSICHT BEI REPARATUREN :	Bei geöffneter Schublade und Defekt der Sicherheitsvorrichtungen besteht die Gefahr unsichtbaren Laserlichts. Niemals direkt in den Laserstrahl sehen.
ATTENZIONE :	Il raggio laser è invisibile. Evitare l'esposizione diretta durante la manutenzione.
IMPORTANTE :	El rayo laser es invisible. Evitar la exposición directa en el momento del mantenimiento.


IMPORTANT SAFETY NOTICE

There are special components used in this equipment which are important for safety. These parts are marked by  symbol on the schematic circuit diagrams and replacement part list. It is essential that these safety critical components are replaced with the manufacturer's specified parts to prevent electric shock, fire, or other hazards. Do not attempt to modify the original design without permission of the manufacturer.


REMARQUES DE SECURITE IMPORTANTE

Il y a des composants spéciaux utilisés dans cet appareil qui sont importants pour la sécurité. Ces pièces sont repérées par un symbole  sur les schémas de principes et la liste de pièces détachées. Il est essentiel que ces composants de sécurité soient remplacés par les pièces originales indiquées par le constructeur pour éviter les chocs électriques, feux ou autres risques. Ne tentez pas de modifier la conception originale sans autorisation du constructeur.


WICHTIGER SICHERHEITSHINWEIS

In diesem Gerät wurden sicherheitsrelevante  Komponenten verwendet. Diese Teile sind im Schaltbild und in der Ersatzteilliste mit einem Symbol markiert. Es ist wichtig, dass diese kritischen Komponenten ausschließlich durch solche ersetzt werden, die den Spezifikationen des Herstellers entsprechen. Die Produkthaftung des Herstellers erlischt bei Einsatz von nicht den Spezifikationen entsprechenden Sicherheitsbauteilen und bei eigenmächtigen Schaltungsänderungen.

IMPORTANTE INFORMAZIONE DI SICUREZZA

Ci sono speciali componenti usati in questa apparecchiatura che sono importanti per la sicurezza. Queste parti sono facilmente identificabili, sullo schema e sulla lista parti, da un apposito simbolo . È indispensabile che questi componenti di sicurezza, nel caso di alterazioni o guasti, vengano sostituiti con specifici ricambi originali per evitare shock elettrici, fuoco o altri rischi. Non modificare mai il circuito senza autorizzazione della casa costruttrice.

AVISO IMPORTANTE SOBRE SEGURIDAD

En este equipo se utilizan componentes especiales que son muy importantes para la seguridad. Están marcados con el símbolo  en los esquemas eléctricos y en las listas de repuestos. Es fundamental que estos componentes críticos de seguridad, sean reemplazados por las piezas originales indicadas por el fabricante para evitar los peligros de electrocución, de fuego, etc. y no modificar el diseño original sin autorización del fabricante.

EN Prevention of electro static discharge (esd) to Electrostatically Sensitive Devices (ESD)

Some semiconductor devices can be damaged easily by static electricity (integrated circuits, some field-effect transistors and semiconductor chip components). The following techniques should be used to help reduce the incidence of component damage caused by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground or wear a discharging wrist strap device, which should be removed for potential shock reasons prior to applying power to the unit under test.
2. After removing an electrical assembly equipped with ESD devices, place the assembly on a conductive surface such as aluminum foil.
3. Use only a grounded-tip soldering iron to solder or unsolder ESD devices.
4. Use only an anti-static solder removal device.
5. Do not use freon-propelled chemicals.
6. Do not remove a replacement ESD device from its protective package until immediately before you are ready to install it.
7. Immediately before removing the protective materials from the leads of a replacement ESD device, touch the protective material to the chassis or circuit assembly into which the device will be installed.
CAUTION : Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.
8. Minimize bodily motions when handling unpackaged replacement ESD devices

FR Prévention des composants et sous-ensembles contre les ESD (Décharge d'Electricité Statique)

Certains semi-conducteurs peuvent être facilement endommagés par l'électricité statique (les circuits intégrés et certains transistors à effet de champs, les composants semi-conducteurs de type chip ainsi que les diodes à émission laser équipant les lecteurs optiques). Les précautions suivantes doivent être utilisées pour réduire l'incidence des dommages causés par l'électricité statique.

1. Immédiatement avant de manipuler tout composant semi-conducteur ou ensemble équipé de semi-conducteurs, éliminez toute charge électrostatique de votre corps en touchant une terre connue. Ou bien, mettez un bracelet antistatique, qui doit être retiré, pour des raisons de choc électrique, avant de mettre l'appareil sous tension.
2. Après démontage d'un ensemble électrique équipé d'éléments sensibles aux ESD, Placez l'ensemble sur une surface conductrice telle qu'une feuille d'aluminium.
3. N'utilisez qu'un fer à souder relié à la masse pour souder ou dessouder ces composants.
4. Pour dessouder, n'utilisez que du matériel antistatique
5. N'utilisez pas de produits chimiques à propulsion de fréon.
6. Ne retirez pas ces composants de leur emballage de protection jusqu'à ce que vous soyez prêt à l'installer.
7. Juste avant de retirer la protection des broches de ces composants, touchez la protection sur le châssis ou le circuit dans lequel le composant va être installé.
ATTENTION : Assurez-vous que le châssis ou le circuit n'est pas sous tension, et observez toutes les autres précautions de sécurité.
8. Minimisez les déplacements corporels lorsque vous manipulez un de ces composants de remplacement déballé.

DE Vermeidung von Elektrostatischer Entladung (ESD)

Manche elektronische Komponenten wie Transistoren, Integrierte Schaltkreise oder Chipelemente können leicht durch ESD beschädigt oder zerstört werden. Die folgenden Richtlinien helfen Schäden durch ESD zu vermeiden.

1. Unmittelbar vor dem Hantieren Halbleitern oder Baugruppen mit Halbleitern leiten Sie die statische Aufladung Ihres Körpers durch Berühren einen geerdeten Gegenstandes ab. Beschaffen Sie sich ein leitendes Handschellenband. Dieses müssen Sie allerdings vor dem Einschalten des zu prüfenden Gerätes ablegen.
2. Nach dem Ausbau einer empfindlichen elektronischen Baugruppe legen Sie diese auf einen leitende Unterlage wie Aluminium-Folie um eine elektrostatische Entladung zu vermeiden.
3. Benutzen Sie für Lotarbeiten an empfindlichen Komponenten einen geerdeten LötKolben.
4. Benutzen Sie antistatisches Entlötzergzeug.
5. Verwenden Sie keine Sprays, die Freon als Treibmittel enthalten. Diese können ausreichend elektrostatische Ladung erzeugen, um empfindliche Komponenten zu schädigen.
6. Entfernen Sie die Antistatik-Schutzverpackung (Alu-Folie, Leitgummi, Leitfolie, ..) von Komponenten und Baugruppen erst wenn Sie diese benötigen.
7. Unmittelbar vor dem Entfernen der Schutzverpackung führen Sie ein Potentialausgleich durch Berühren des Gerätes mit der Komponente/Baugruppe durch. ACHTUNG: Stellen Sie sicher, dass das Gerät nicht unter Spannung steht und beachten Sie alle einschlägigen Sicherheitsvorschriften.
8. Bewegen Sie sich beim Hantieren mit empfindlichen Komponenten/Bausteinen möglichst wenig, da die Reibung Ihrer Kleidung oder der Füße auf dem Bodenbelag elektrostatische Ladung erzeugen kann.

IT Azioni preventive contro le scariche elettrostatiche (esd) sui Dispositivi Sensibili Elettrostaticamente (ESD)

Alcuni semiconduttori possono essere facilmente danneggiati da elettricità statica (circuiti integrati, alcuni transistor ad effetto di campo e componenti chip semiconduttori). Al fine di ridurre l'incidenza dei componenti danneggiati a causa di elettricità statica si dovrebbero osservare le seguenti precauzioni.

1. Immediatamente prima di maneggiare qualsiasi tipo di componente semiconduttore o di apparecchio che impiega semiconduttori, scaricare le possibili cariche elettrostatiche del proprio corpo toccando un punto sicuramente collegato a terra. In alternativa, indossare un apposito braccialetto antistatico che dovrebbe però essere tolto, per possibili potenziali shock, immediatamente prima di alimentare l'apparecchiatura sotto test.
2. Dopo il disimballo porre l'apparecchiatura equipaggiata con dispositivi ESD su una superficie conduttiva tipo foglio di alluminio.
3. Usare saldatori con punta a massa per saldare o dissaldare dispositivi ESD.
4. Usare solo saldatori antistatici.
5. Non usare prodotti chimici tipo freon.
6. Rimuovere il dispositivo ESD dal suo imballo protettivo solo immediatamente prima del suo utilizzo.
7. Immediatamente prima della rimozione del materiale protettivo dai piedini del dispositivo ESD di ricambio, toccare con il materiale protettivo il telaio o la massa del circuito stampato dove il dispositivo deve essere inserito.
ATTENZIONE : Assicurarsi che il circuito o il telaio non sia alimentato, e osservare tutte le altre precauzioni di sicurezza.
8. Limitare gli spostamenti quando si maneggia un dispositivo ESD disimballato.

ES Prevención contra descargas electro-estáticas (esd) para los DISPOSITIVOS SENSIBLES electrostáticamente (ESD)

Algunos dispositivos semiconductores, pueden ser dañados fácilmente por la electricidad estática (los circuitos integrados, algunos transistores de Efecto de Campo y los semiconductores "chip"). Las siguientes técnicas pueden ser utilizadas para ayudar a reducir la destrucción de los componentes causada por la electricidad estática.

1. Inmediatamente antes de manejar cualquier componente semiconductor o conjunto equipado con semiconductores, elimine la carga electrostática de su cuerpo tocando alguna toma de tierra conocida o utilizar una correa conductora conectada a una toma de tierra que se pone en la muñeca la cual debe ser quitada (por razones de seguridad) antes de conectar la alimentación al equipo bajo prueba.
2. Después de quitar un conjunto equipado con componentes ESD, coloque el conjunto sobre una superficie conductora, como papel aluminio.
3. Utilizar únicamente soldadores con la punta conectada a la toma de tierra para soldar o desoldar componentes ESD.
4. Utilizar solamente soldadores antiestáticos para quitar componentes.
5. No utilizar productos químicos con gas freón como propelente.
6. No sacar de su embalaje protector el nuevo componente ESD hasta inmediatamente antes de estar todo preparado para montarlo.
7. Inmediatamente antes de quitar los materiales de protección de las patillas del componente, tocar el material protector al chasis del conjunto donde se vaya a montar el componente.
CUIDADO : Asegúrese de que la alimentación no esté aplicada al chasis o circuito, y cumpla todas las precauciones de seguridad.
8. Maneje sin movimientos bruscos el componente ESD una vez desempaquetado.

HANDLING THE OPTICAL PICKUP

The laser diode used in the optical pickup may break down due to potential differences caused by electricity produced by clothing or the human body, care should therefore be taken to prevent electrostatic discharge whilst repairing the optical pickup.

The following method is recommended.

- 1) Place a conductive sheet on the work bench (The black sheet used for wrapping repair parts.)
- 2) Place the set on the conductive sheet so that the chassis is grounded to the sheet.
- 3) Place your hands on the conductive sheet (doing this gives them the same ground as the sheet).
- 4) Remove the optical pickup block
- 5) Perform work on top of the conductive sheet. Be careful not to let your clothes or any other static sources to touch the unit.
- * Grounding the Human Body, use an antistatic wrist strap to discharge static electricity from your body.
- * Grounding the work place, use either an antistatic matt or a sheet of steel on the area where the optical pickup is to be placed and ground the matt/sheet.
- 6) Short the short terminal on the PCB, which is inside the Pickup Assembly, before disconnecting the flexible cable for replacing the Pickup. (The short terminal is shorted when the Pickup Assembly is being lifted or moved.)
- 7) After replacing the Pickup, open the short terminal on the PCB.

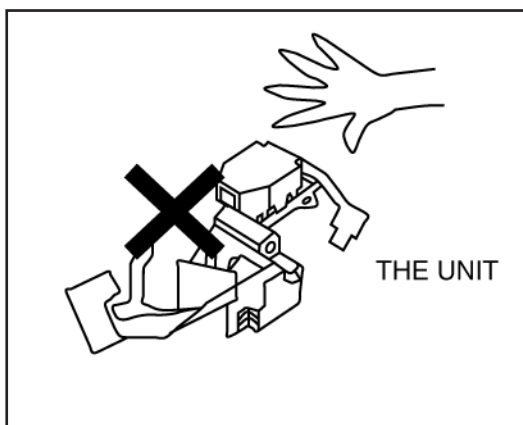


Fig. 1

MANIPULATION DU BLOC OPTIQUE

La diode laser utilisée dans le bloc optique peut se détériorer à cause d'une différence de potentiel causé par l'électricité produite par les vêtements ou le corps humain, par conséquent des précautions doivent être prise pour éviter les décharges électrostatiques pendant la réparation du bloc optique.

Il est recommandé de suivre la méthode suivante.

- 1) Placez une feuille conductrice sur le banc de travail (la feuille noire utilisée pour envelopper les pièces détachées).
- 2) Placez l'ensemble sur la feuille conductrice pour que le châssis soit mis à la masse par la feuille.
- 3) Mettez vos mains sur la feuille conductrice (en faisant ceci, vous leur donnez la même masse que la feuille)
- 4) Retirez le bloc optique
- 5) Travaillez en haut de la feuille conductrice. Prenez soin de ne pas laisser vos vêtements ou autre source statique toucher le bloc optique.
- * Mise à la terre du corps humain : utilisez un bracelet antistatique pour décharger l'électricité statique de votre corps.
- * Mise à la terre du poste de travail : placez soit un tapis antistatique, soit une feuille d'acier sur le banc de travail où vous poserez le bloc optique après avoir relié le tapis ou la feuille à la masse.
- 6) Pour remplacer le bloc optique, soudez le court-circuit sur le circuit imprimé qui se trouve sur l'ensemble optique, avant de déconnecter le câble flexible (le court-circuit est soudé lorsque l'ensemble optique est levé ou déplacé).
- 7) Après le remplacement du bloc optique, dessoudez le court-circuit sur le circuit imprimé.

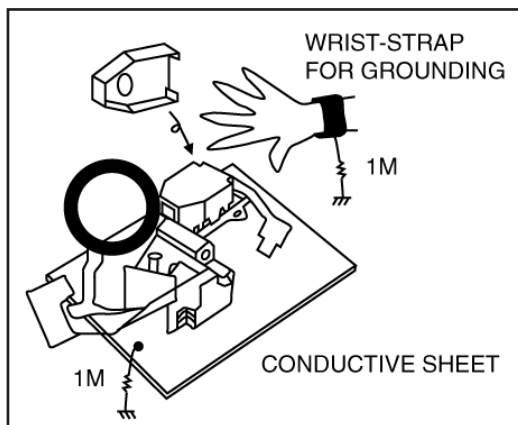


Fig. 2

SERVICE MODE - MODE SERVICE - SERVICE MODE - SERVICE MODE SERVICE MODE - MODO SERVICIO

- EN** **Accessing the SERVICE MENU**
- Connect the recorder to the mains supply and a monitor television using a SCART lead.
 - Switch "ON" the recorder and then press the "MENU" key on the RCU.
 - The recorders "MAIN MENU" will now be displayed on the screen of the television.
 - Next simultaneously press the "STOP", "PAUSE" and "RECORD" keys on the front panel depressed until the Service Menu is displayed on the screen of the television.

- DE** **Aktivierung des SERVICE-MENÜS**
- Verbinden Sie den Recorder mit der Netzspannung und mittels eines SCART-Kabels einem TV-Gerät.
 - Schalten Sie den Recorder mit „ON“ ein und drücken auf der Fernbedienung die „MENU“-Taste.
 - Auf dem Bildschirm wird das Hauptmenü des Recorder angezeigt.
 - Drücken Sie am Bedienfeld des Recorders gleichzeitig die Tasten „STOP“, „PAUSE“ und „RECORD“ bis auf dem Bildschirm das Service-Menü angezeigt wird.

- ES** **Acceso al modo servicio.**
- Conectar el aparato a la red. Un menú aparecerá.
 - Seleccionar el menú principal pulsando la tecla "MENU" del telemando
 - Pulsar a la vez las teclas "STOP", "PAUSE" y "RECORD".
 - Mantener las 3 teclas pulsadas hasta que aparezca el menú principal del Modo Servicio

FORMAT / INITIALIZATION - FORMATAGE / INITIALISATION FORMATIERUNG / NEUINITIALISIERUNG - FORMATTAZIONE/INIZIALIZZAZIONE FORMATEO / INICIALIZACIÓN

- EN**
- To ERASE and RE-FORMAT the hard drive,**
 - Switch "ON" the recorder and wait until "MENU" is displayed in the front panel display.
 - Simultaneously press the "AV" and "STOP" keys on the front panel until the display changes to read "FORMAT" and then release the keys.
 - The hard drive will now be re-formatted and all video recordings, MP3 audio and JPEG picture files will be erased.
 - When the hard drive has been re-formatted the display will flash "FORMAT OK" for a split second.
 - To complete the process, the recorder will switch itself "OFF" and then back "ON" again.
 - To RE_INITIALIZE the recorder to factory defaults settings,**
 - Switch "ON" the recorder and wait until "MENU" is displayed in the front panel display.
 - Simultaneously press the "STOP", "PAUSE" and "STANDBY" keys on the front panel until the display changes to read "INIT" and then release the keys.
 - When the recorder has been re-initialized the display will flash "INIT OK" for a split second.
 - Now all the previous setting will be reset to the original factory default settings.

- DE**
- Formatierung der Festplatte**
 - Schalten Sie das Gerät ein; das normale Hauptmenü erscheint.
 - Drücken Sie am Gerät gleichzeitig die Tasten AV und STOP bis auf dem Geräte-Display "FORMAT" erscheint
 - Die Formatierung der Festplatte benötigt einige Zeit. Wenn die Formatierung beendet ist, erscheint kurz "FORMAT OK", das Gerät schaltet sich selbstständig kurz aus und dann wieder ein.
 - ACHTUNG: Bei der Formatierung der Festplatte werden alle Video-, JPEG- und MP3-Dateien gelöscht!
 - Wiederherstellen der Fabrikeinstellungen (Neuinitialisierung)**
 - Schalten Sie das Gerät ein; das normale Hauptmenü erscheint.
 - Drücken Sie am Gerät gleichzeitig die Tasten STOP, PAUSE und STANDBY / ON bis auf dem Geräte-Display "INIT" erscheint.
 - Die Neuinitialisierung des Gerätes benötigt einige Zeit.
 - Wenn die Neuinitialisierung abgeschlossen ist, erscheint "INIT OK".
 - Alle vorherigen Einstellungen sind nun auf die Fabrikeinstellungen zurückgesetzt.

- ES**
- Instrucciones para re-formatear el disco duro.**
 - Conectar el aparato a la red. Aparecerá el menú.
 - Mantener pulsadas las teclas AV y STOP en el panel frontal hasta que aparezca en el display, el mensaje "FORMAT"
 - El formateo se realiza en unos pocos segundos. Cuando se haya completado, se mostrará el mensaje "FORMAT OK".
 - A continuación, él solo se apagará y encenderá de nuevo.
 - Todos los ficheros de MP3, JPEG y títulos de vídeo han sido borrados.

- FR** **Accès au mode service.**
- Mettre l' appareil sous tension. Le menu principal apparait.
 - Sélectionner le menu principal en appuyant sur la touche "MENU" de la télécommande
 - Appuyer sur les touches "STOP", "PAUSE" et "RECORD".
 - Maintenir enfoncées les touches ensembles jusqu'à l'apparition du menu principal du mode service

- IT** **Accesso al Service Mode**
- Collegare l'apparecchio alla rete
 - Premere il tasto "MENU" del telecomando per far apparire il Menu principale.
 - Premere e mantenere premuti i tasti "STOP", "PAUSA" e "RECORD" fino all'apparizione del menu principale del service Mode.

Service Menu			
I2C BUS I	OK	VERSION	
I2C BUS II	OK	ST20	A2LEU_S4.01
		ST9	N2_S3.10
USB COM	OK	KDB	S2.00
HDD Status	OK	Bootloader	C3-S2.00
		Gob Version	0x5
HDD Error	0	TVM50x	0x3a20 0x0107

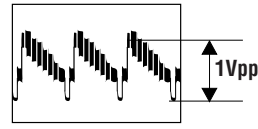
- FR**
- Formatage du disque dur.**
 - Mettre l' appareil sous tension. Le menu principal apparait.
 - Appuyer et maintenir enfoncées les touches "AV" et "STOP" de la face avant jusqu'à l'apparition du message "FORMAT" dans l'afficheur
 - le formatage s'effectue pendant un temp relativement court .
 - l'orsqu'il est complet le message "FORMAT OK" s'affiche.
 - L'appareil commute ON et OFF sequentiellement. Les fichiers MP3 et JPEG et les titres video sont effacés.
 - Initialisation des valeurs par défaut.**
 - Mettre l' appareil sous tension. Le menu principal apparait.
 - Appuyer et maintenir enfoncées les touches "STOP", "PAUSE" et "STANDBY" / "ON" du clavier de la face avant jusqu'à l'apparition du message "INIT" dans l'afficheur.
 - L'orsque l'initialisation est complète le message "INIT OK" s'affiche. Les réglages son initialisés aux valeurs usines.

- IT**
- Formattazione del disco fisso.**
 - Collegare l'apparecchio alla rete e far visualizzare il menu principale.
 - Premere e mantenere premuti i tasti "AV" e "STOP" del frontale fino all'apparizione del messaggio "FORMAT" sul display.
 - La formattazione viene eseguita in un tempo relativamente breve e, alla fine di questa fase, verrà visualizzato il messaggio "FORMAT OK" sul display.
 - L'apparecchio commuta ON e OFF in sequenza. I titoli MP3, JPEG e video sono cancellati.
 - Inizializzazione dei valori di default**
 - Collegare l'apparecchio alla rete e far visualizzare il menu principale.
 - Premere e mantenere premuti i tasti "STOP", "PAUSA" e "STANDBY/ON" del frontale fino all'apparizione del messaggio "INIT" sul display.
 - Alla fine dell'operazione, verrà visualizzato il messaggio "INIT OK" sul display.
 - Le regolazioni sono inizializzate ai valori di "DEFAULT".

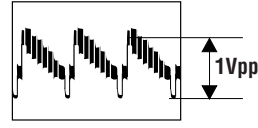
- 2.Inicialización de los ajustes a los valores por defecto.**
- Conectar el aparato a la red. Aparecerá el menú.
 - Mantener pulsadas las teclas STOP, PAUSE y STANDBY / ON en el panel frontal hasta que salga el mensaje "INIT" en el display.
 - En unos pocos segundos se habrán restaurado los ajustes.
 - Cuando se ha completado, se verá el mensaje "INIT OK".
 - Los ajustes habrán sido inicializados a los valores por defecto de fábrica.

CHECKS AND MEASUREMENTS - CONTRÔLES ET VERIFICATIONS - CONTROLLI E VERIFICHE - AJUSTES Y COMBROBACIONES

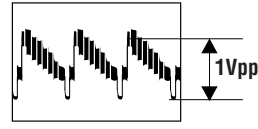
Hard disk Video Record / Playback - Contrôle Vidéo Enregistrement / Lecture du Disque dur - Videoaufnahme/-Wiedergabe von Festplatte
Controllo Registrazione/Riproduzione su Hard Disc - Grabacion de Video / Lectura del disco duro

N°	Item	Mode & Signal	Test equipment	Test point	Adjustment point	Description
A	CVBS RECORD / PLAY level	REC / PB Select AV1 colour bar test pattern 20 BW125 (Top SCART) 1Vpp record then play enregistrer puis lecture	Oscilloscope	AV1 pin19 BW125 (Top SCART)	None	Check for CVBS= 1Vpp ± 0.1Vpp 

Video Playback Output Signal check - (Disk) Controle Video Lecture Video - Überprüfung Videowiedergabepegel - Controllo uscita Riproduzione Video
Nivel de salida de reproduccion de video

N°	Item	Mode & Signal	Test equipment	Test point	Adjustment point	Description
B	CVBS PB level (DVD)	Select AV1 PAL / SECAM colour bar test pattern	Oscilloscope (DVD disk test)	AV1 pin19 BW125 (Top SCART)	None	Check for CVBS= 1Vpp ± 0.1Vpp BURST = 286mVpp ± 28.6 mVpp 

Video -E to E (AV input/AV output) - Video EE (AV . Entree / Sortie AV) - Video EE (AV-Eingang/AV-Ausgang) - Video -EE (AV input/AV output - Video EE (entrada / salida AV)

N°	Item	Mode & Signal	Test equipment	Test point	Adjustment point	Description
C	CVBS EE level	Select AV1 PAL / SECAM colour bar test pattern 20 BW125 (Top SCART) 1Vpp	Oscilloscope	AV1 pin19 BW125 (Top SCART)	None	Check for CVBS= 1Vpp ± 0.1Vpp 

POWER SUPPLY INTERFACE - INTERFACE ALIMENTATION - NETZTEIL - ALIMENTAZIONE - INTERFAZ ALIMENTACIÓN

SCHEMATIC DIAGRAM - SCHEMA DE PRINCIPE - SCHALTBILD - SCHEMA - ESQUEMA

Note :
Power Supply primary circuit measurements.
- Use only (PGND) connection point.

Attention :
Mesure dans la partie primaire de l'alimentation
- Utiliser la masse du bloc alimentation (PGND).

Achtung :
Bei Messungen im Primärnetzteil
Primärnetzteilmasse verwenden (PGND).

Attenzione :
misure nell'alimentatore primario
- usare massa alimentazione primario (PGND).

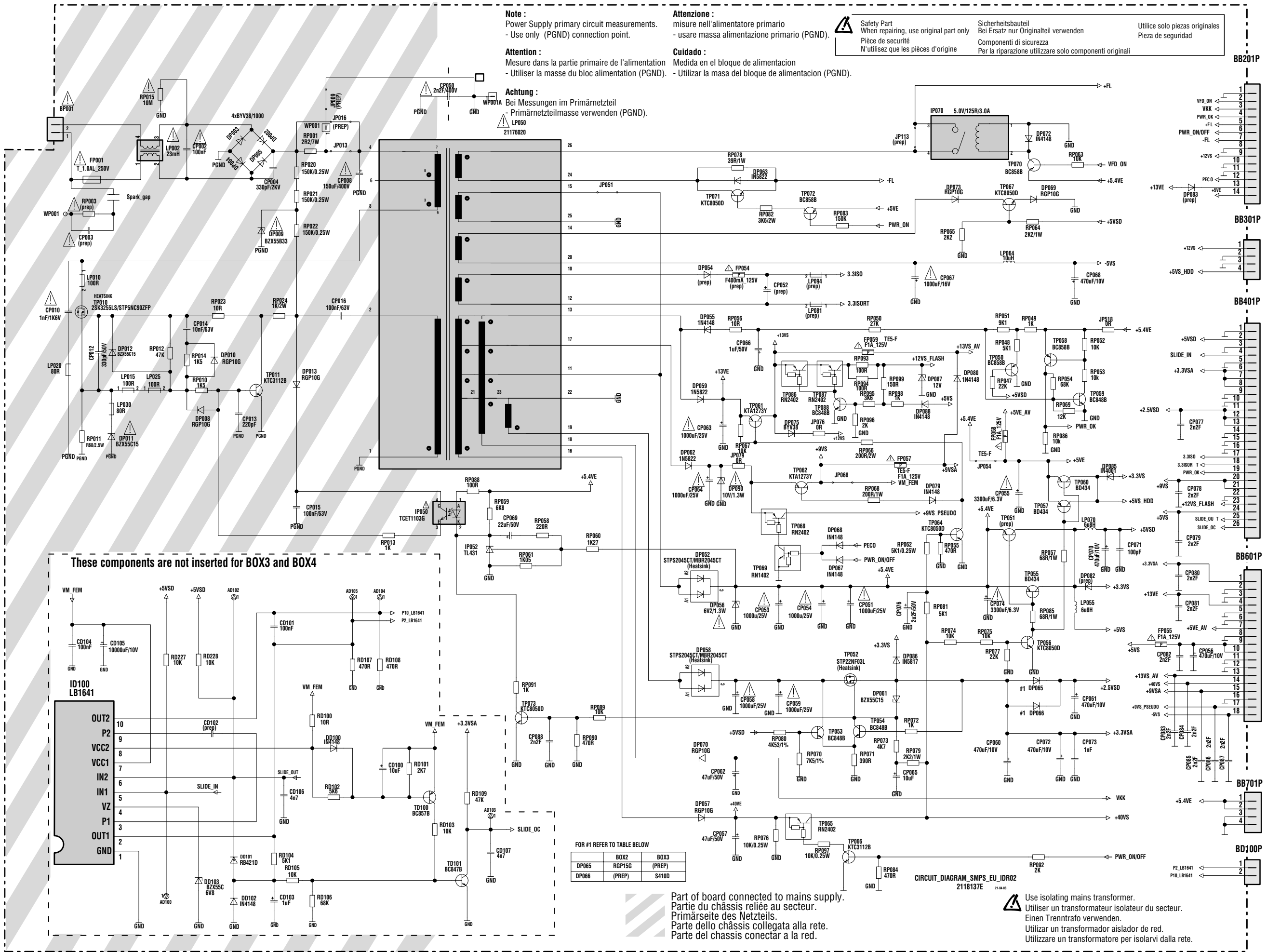
Cuidado :
Medida en el bloque de alimentacion
- Utilizar la masa del bloque de alimentacion (PGND).



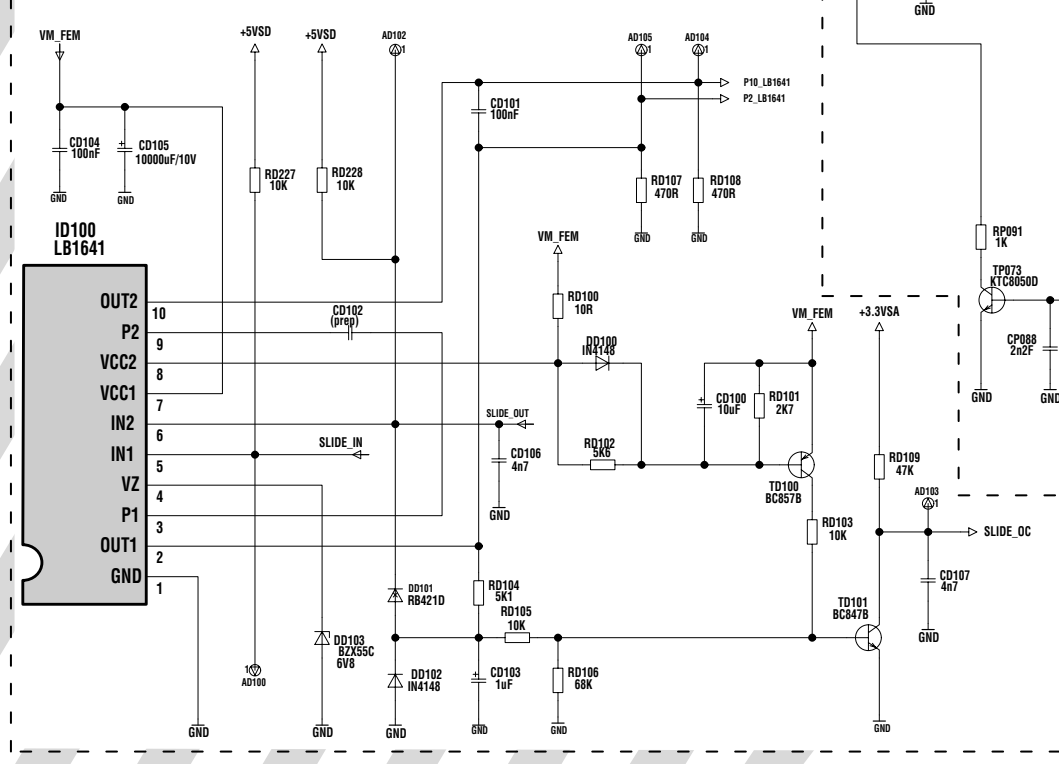
Safety Part
When repairing, use original part only
Pièce de sécurité
N'utilisez que les pièces d'origine

Sicherheitsbauteil
Bei Ersatz nur Originalteile verwenden
Componenti di sicurezza
Per la riparazione utilizzare solo componenti originali

Utilice solo piezas originales
Pieza de seguridad



These components are not inserted for BOX3 and BOX4

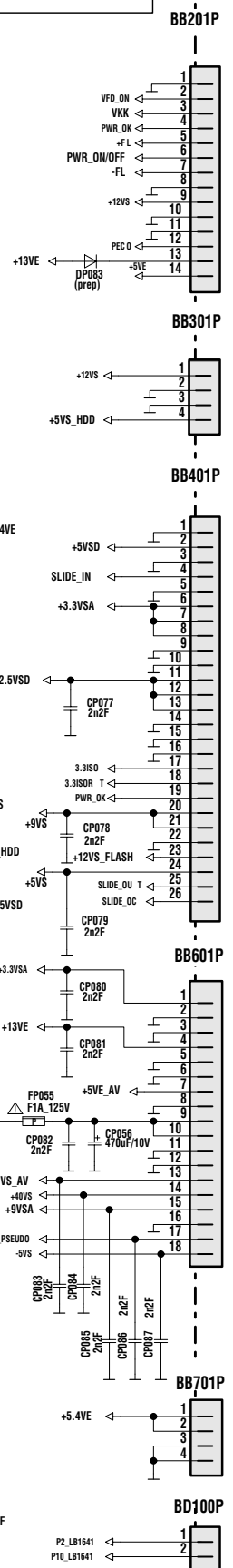


FOR #1 REFER TO TABLE BELOW

	BOX2	BOX3
DP065	RGP15G	(PREP)
DP066	(PREP)	S410D

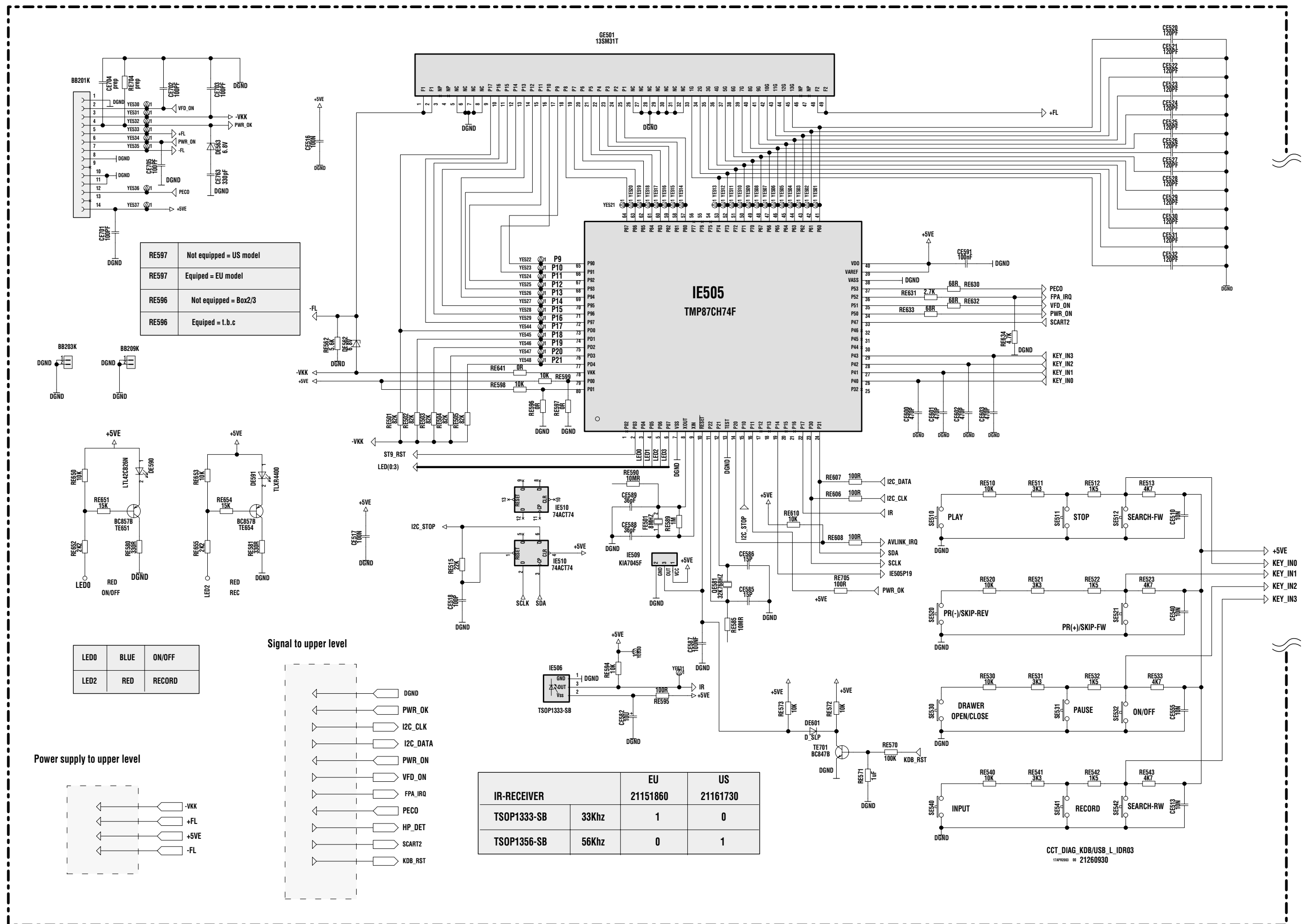
Part of board connected to mains supply.
Partie du châssis reliée au secteur.
Primärseite des Netzteils.
Parte dello chassis collegata alla rete.
Parte dello chassis conectar a la red.

Use isolating mains transformer.
Utiliser un transformateur isolateur du secteur.
Einen Trenntrafo verwenden.
Utilizar un transformador aislador de red.
Utilizzare un trasformatore per isolarvi dalla rete.



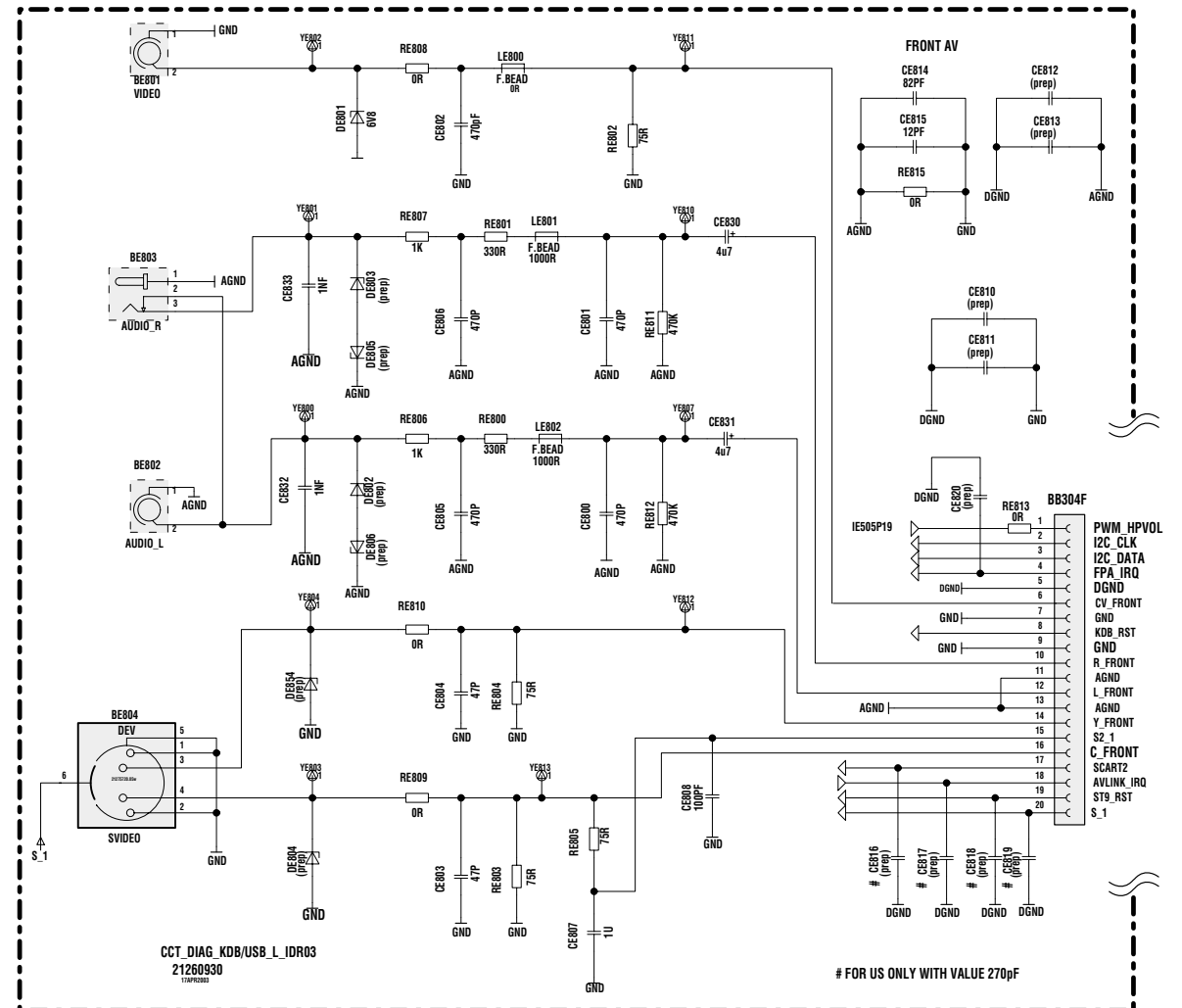
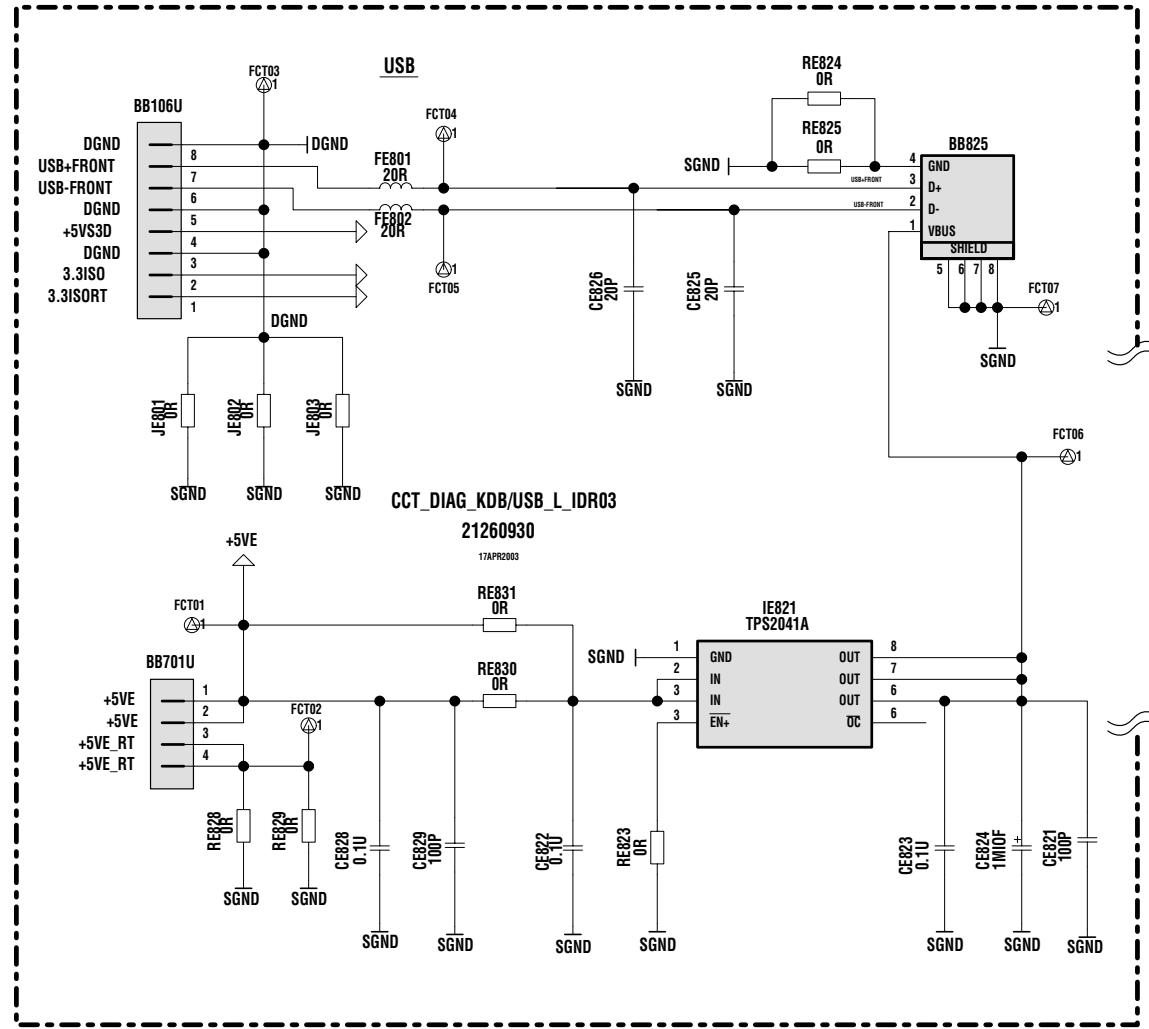
KEYBOARD WITH DISPLAY - PLATINE DE COMMANDES AVEC AFFICHEUR - BEDIENTEIL MIT DISPLAY - TASTIERA CON DISPLAY - PLATINA MANDOS CON VISUALIZADOR

SCHEMATIC DIAGRAM - SCHEMA DE PRINCIPE - SCHALTBILD - SCHEMA - ESQUEMA



USB MODULE - MODULE USB - USB MODUL - MODULO USB - MÓDULO USB

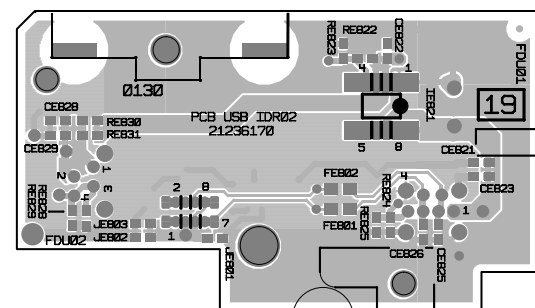
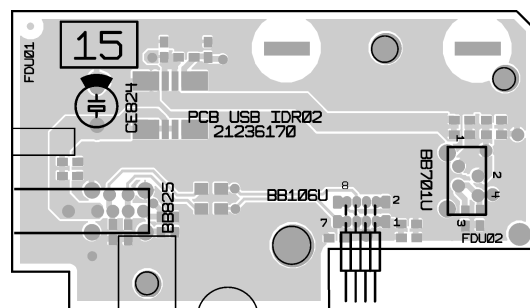
INPUT/OUTPUT - ENTREES/SORTIES - EINGÄNGE/AUSGÄNGE
INGRESSO/USCITA - ENTRADA/SALIDA



USB MODULE - MODULE USB - USB MODUL - MODULO USB - MÓDULO USB

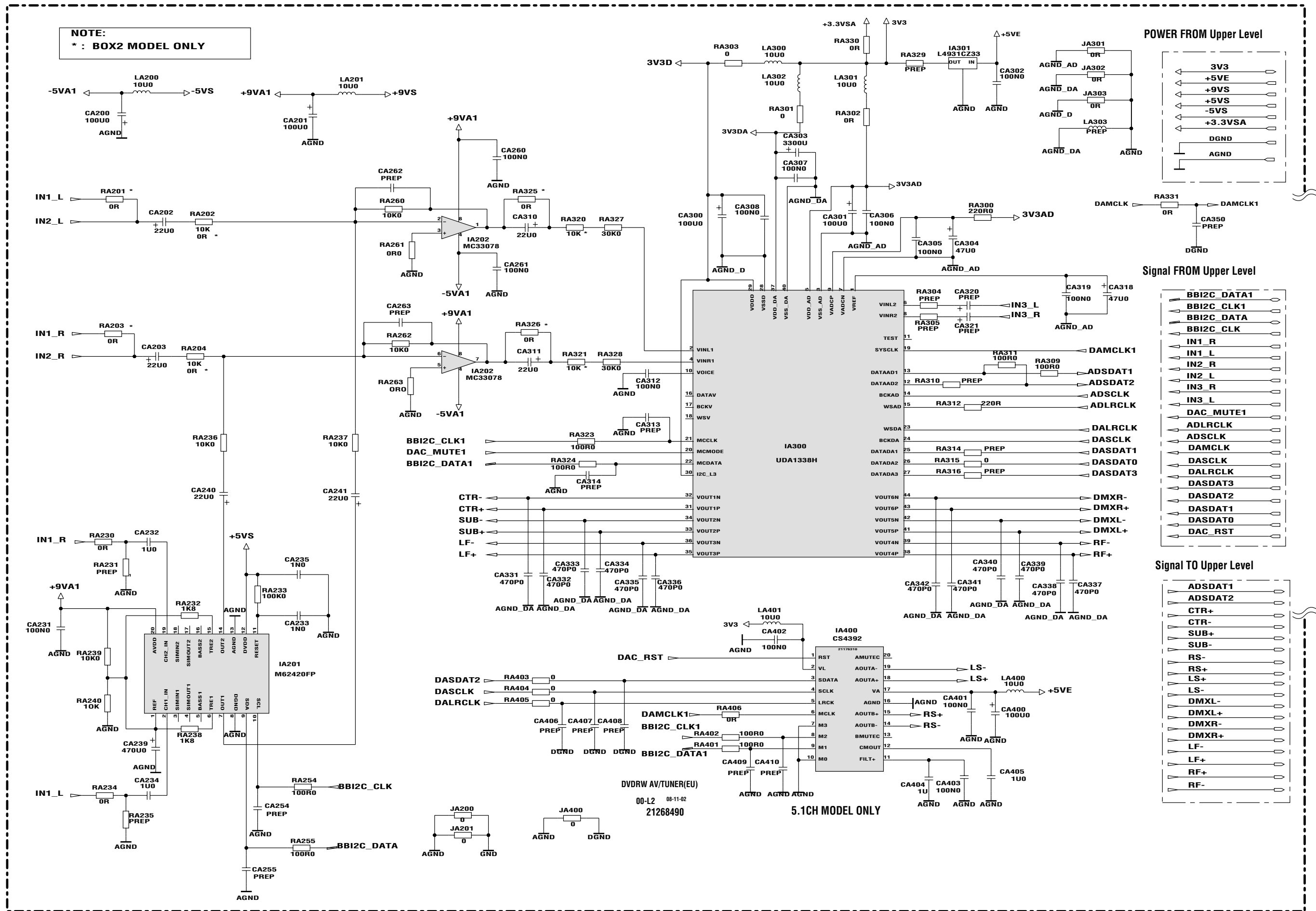
COMPONENT SIDE - COTÉ COMPOSANTS -
BESTÜCKUNGSSEITE - LATO COMPONENTI -
LADO COMPONENTES

SOLDER SIDE - COTÉ CUIVRE - LÖTSEITE -
LATO SALDATURE - LADO DEL COBRE



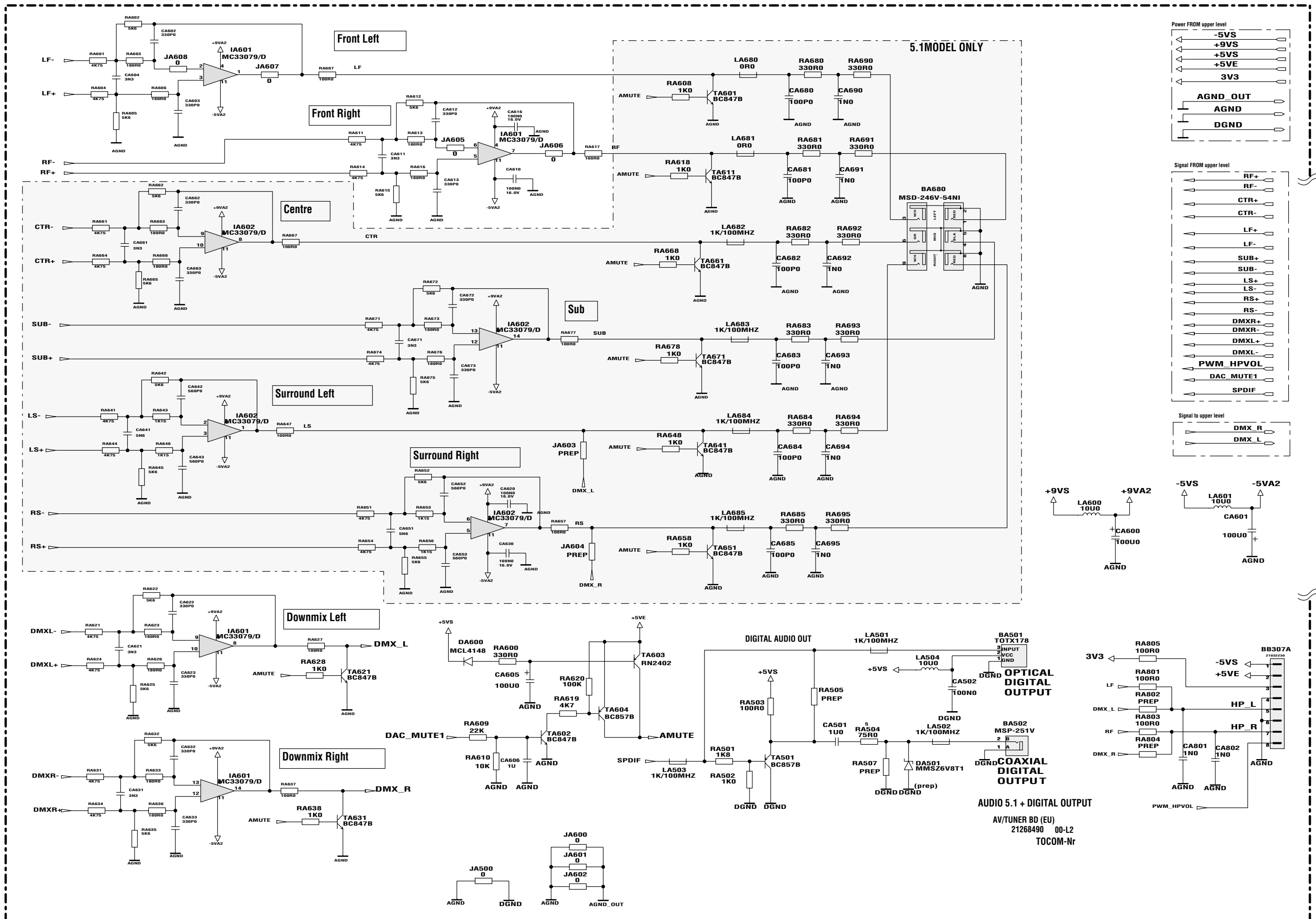
SCART INTERFACE / TUNER SCHEMATIC DIAGRAM - SCHEMA DE L'INTERFACE PER TELEVISION / TUNER - SCHALTBILD EUROPA NORMBUCHSE / TUNER
 SCHEMA DELLA PRESA PERITEL / SINTONIZZATORE - ESQUEMA INTERFAZ EUROTOMA / SINTONIZADOR

(AV TUNER BOARD 2/11)



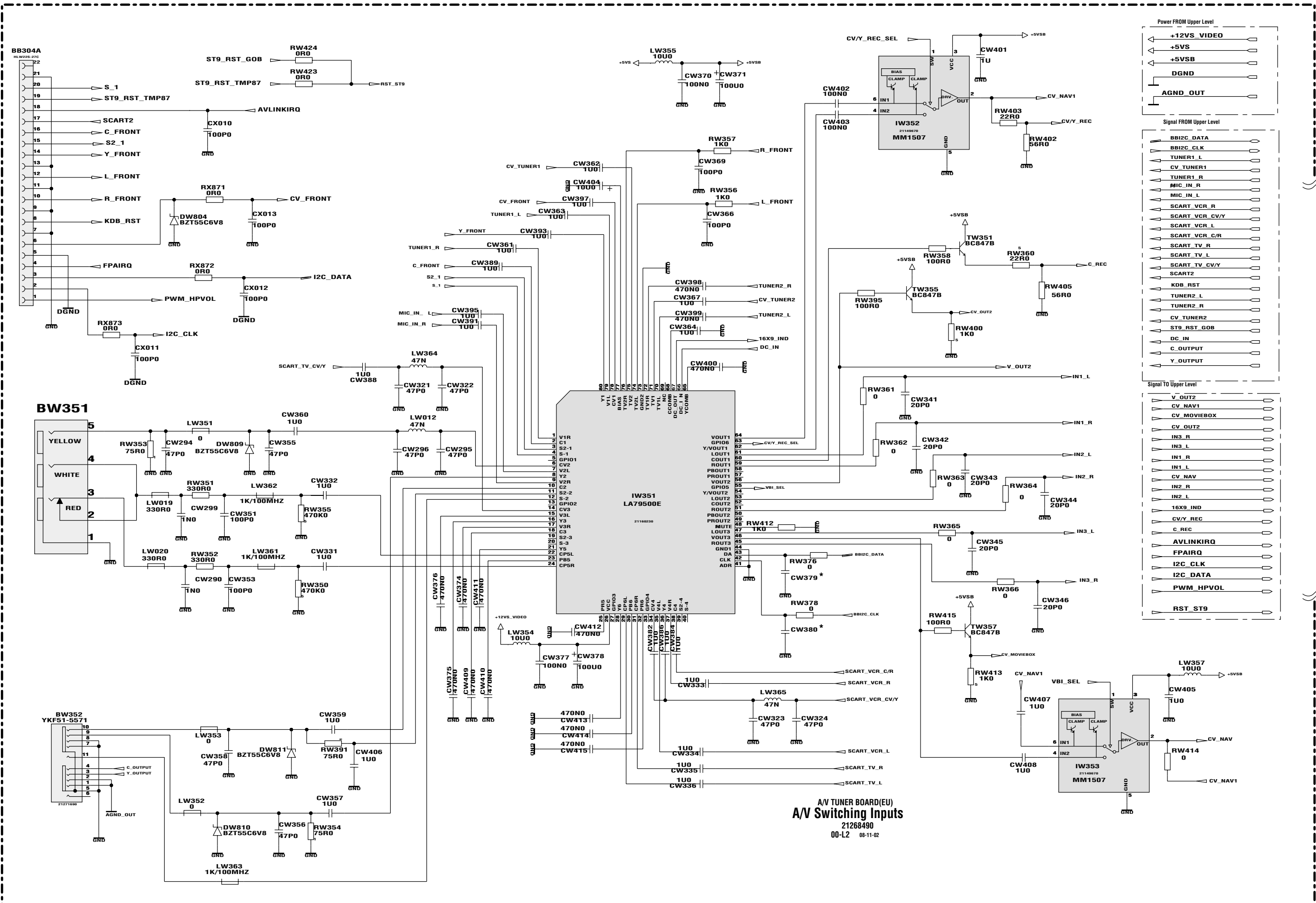
SCART INTERFACE / TUNER SCHEMATIC DIAGRAM - SCHEMA DE L'INTERFACE PERITELEVISION / TUNER - SCHALTBILD EUROPA NORMBUCHSE / TUNER
 SCHEMA DELLA PRESA PERITEL / SINTONIZZATORE - ESQUEMA INTERFAZ EUROTOMA / SINTONIZADOR

(AV TUNER BOARD 3/11)



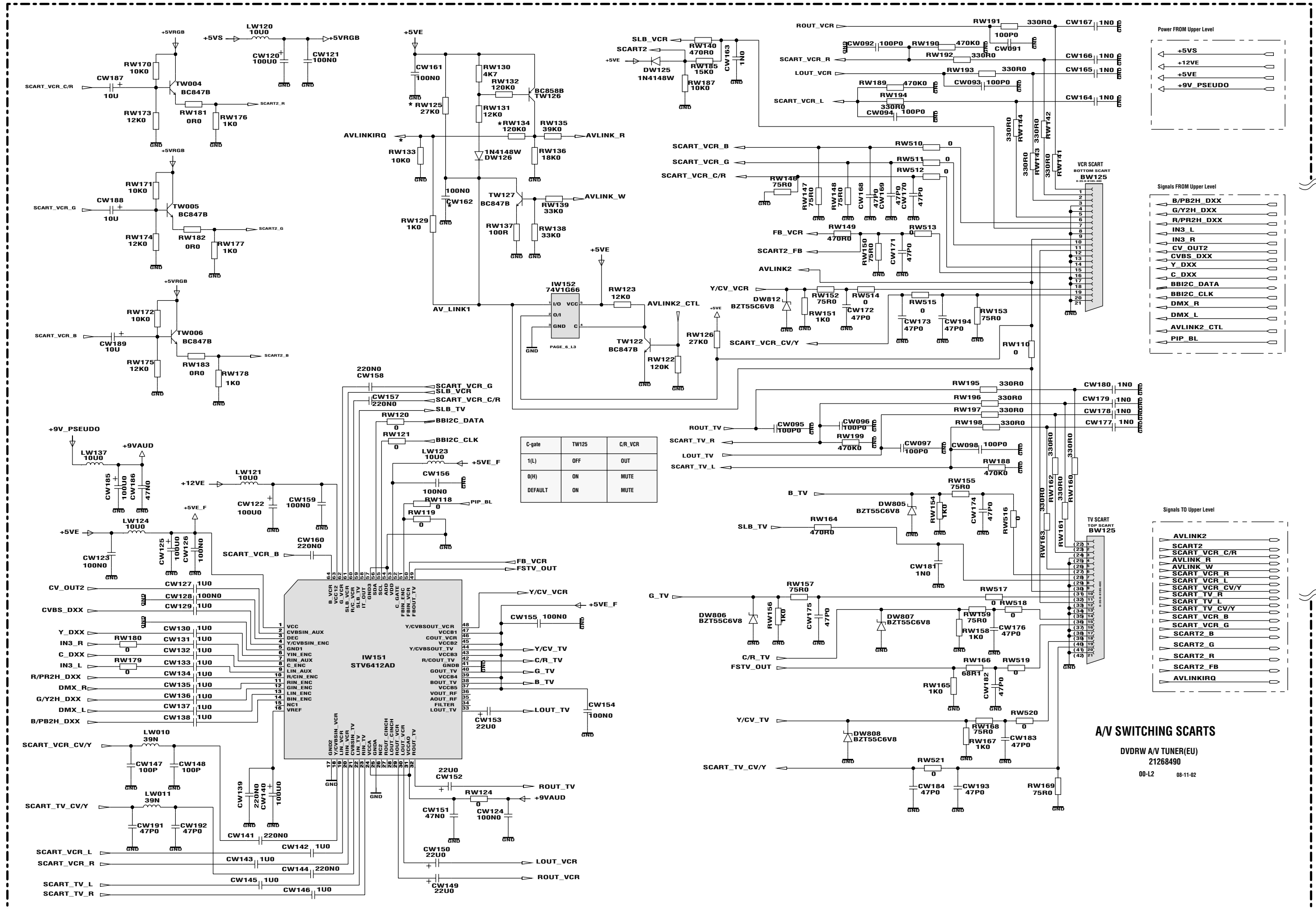
SCART INTERFACE / TUNER SCHEMATIC DIAGRAM - SCHEMA DE L'INTERFACE PER TELEVISION / TUNER - SCHALTBILD EUROPA NORMBUCHSE / TUNER
 SCHEMA DELLA PRESA PERITEL / SINTONIZZATORE - ESQUEMA INTERFAZ EUROTOMA / SINTONIZADOR

(AV TUNER BOARD 5/11)



SCART INTERFACE / TUNER SCHEMATIC DIAGRAM - SCHEMA DE L'INTERFACE PER TELEVISION / TUNER - SCHALTBILD EUROPA NORMBUCHSE / TUNER
 SCHEMA DELLA PRESA PERITEL / SINTONIZZATORE - ESQUEMA INTERFAZ EUROTOMA / SINTONIZADOR

(AV TUNER BOARD 6/11)



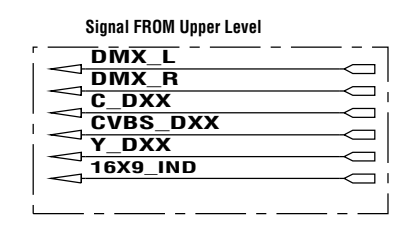
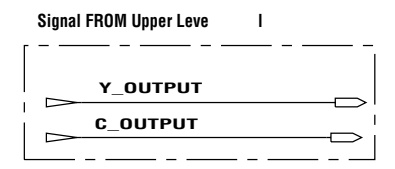
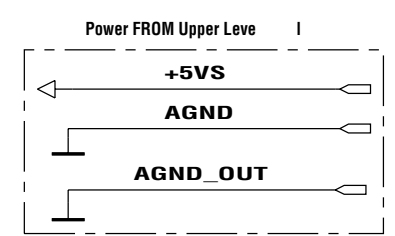
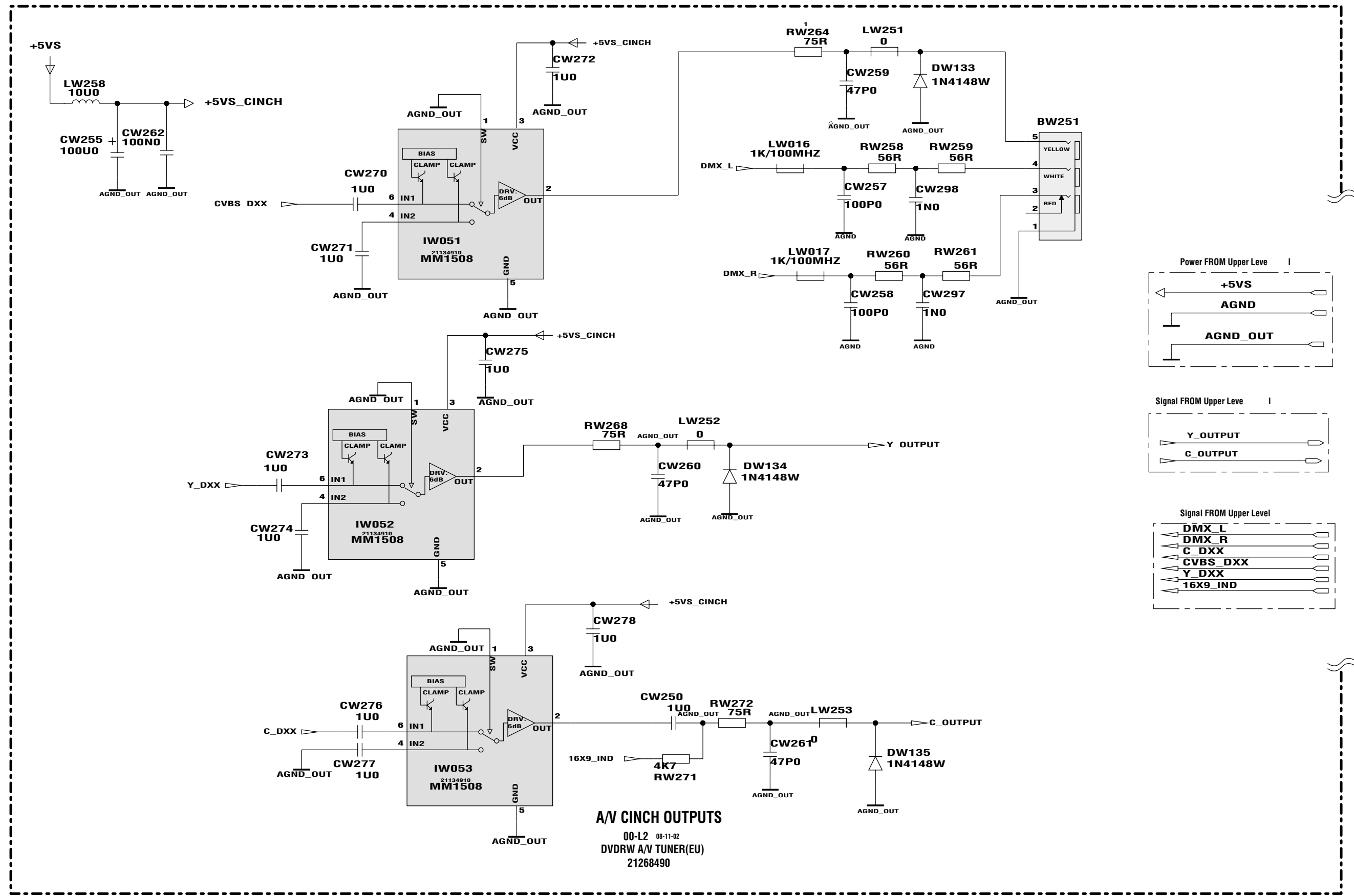
A/V SWITCHING SCARTS

DVDRW A/V TUNER(EU)
21268490

00-L2 08-11-02

SCART INTERFACE / TUNER SCHEMATIC DIAGRAM - SCHEMA DE L'INTERFACE PERITELEVISION / TUNER - SCHALTBILD EUROPA NORMBUCHSE / TUNER
 SCHEMA DELLA PRESA PERITEL / SINTONIZZATORE - ESQUEMA INTERFAZ EUROTOMA / SINTONIZADOR

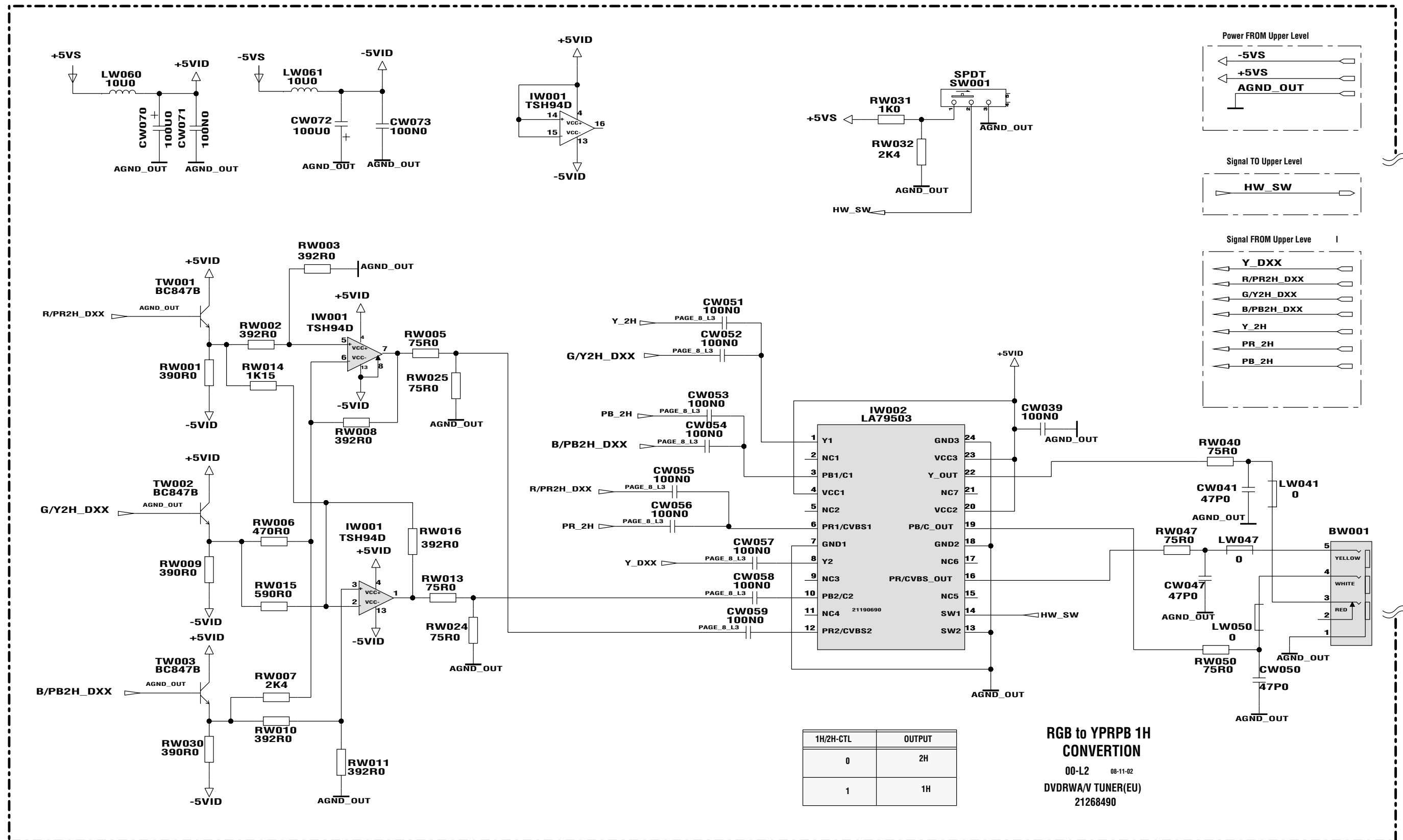
(AV TUNER BOARD 7/11)



A/V CINCH OUTPUTS
 00-L2 08-11-02
 DADRW A/V TUNER(EU)
 21268490

SCART INTERFACE / TUNER SCHEMATIC DIAGRAM - SCHEMA DE L'INTERFACE PERITELEVISION / TUNER - SCHALTBILD EUROPA NORMBUCHSE / TUNER
 SCHEMA DELLA PRESA PERITEL / SINTONIZZATORE - ESQUEMA INTERFAZ EUROTOMA / SINTONIZADOR

(AV TUNER BOARD 8/11)

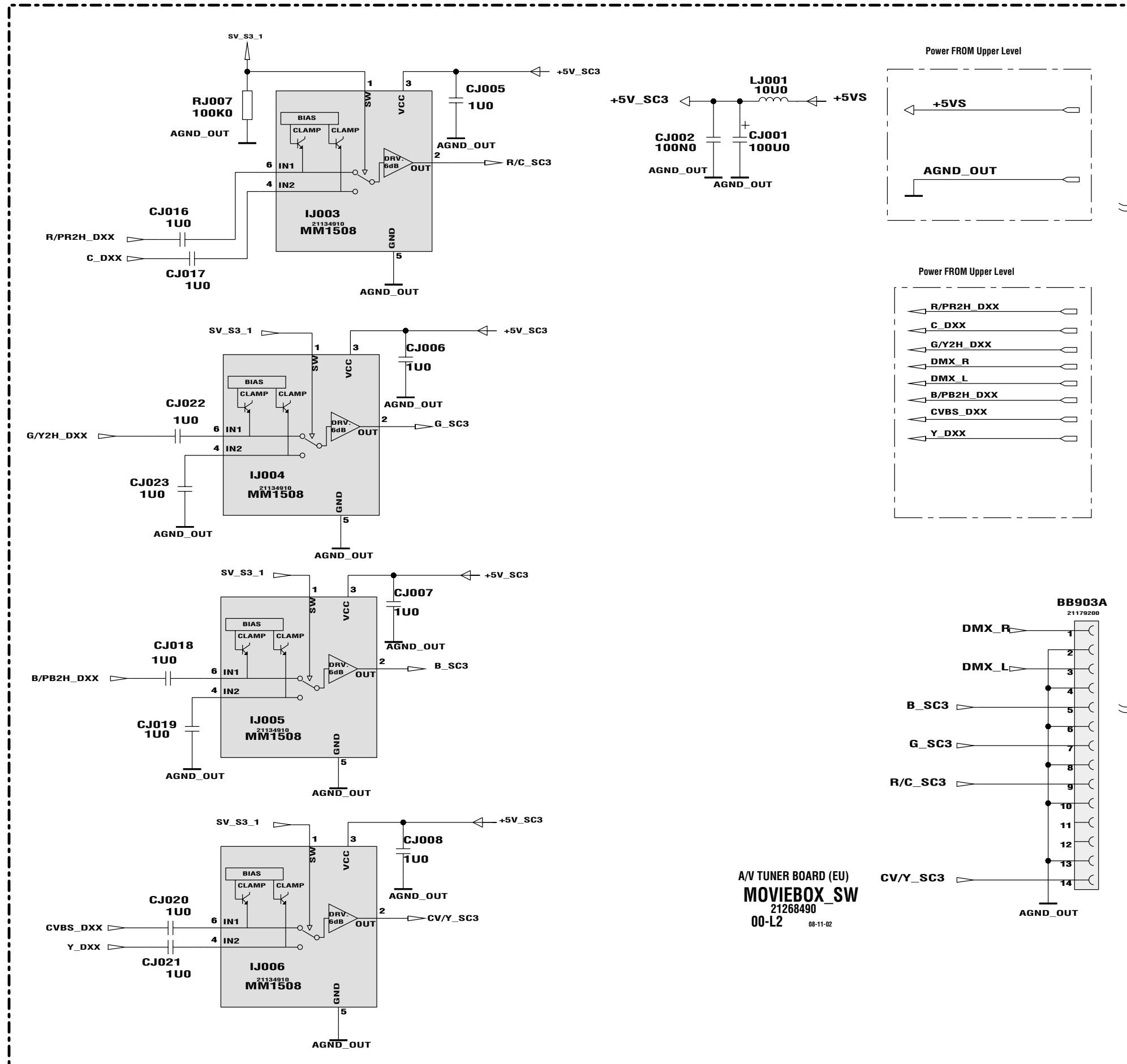


1H/2H-CTL	OUTPUT
0	2H
1	1H

**RGB to YPRPB 1H
 CONVERSION**
 00-L2 08-11-02
 DVDRAW/V TUNER(EU)
 21268490

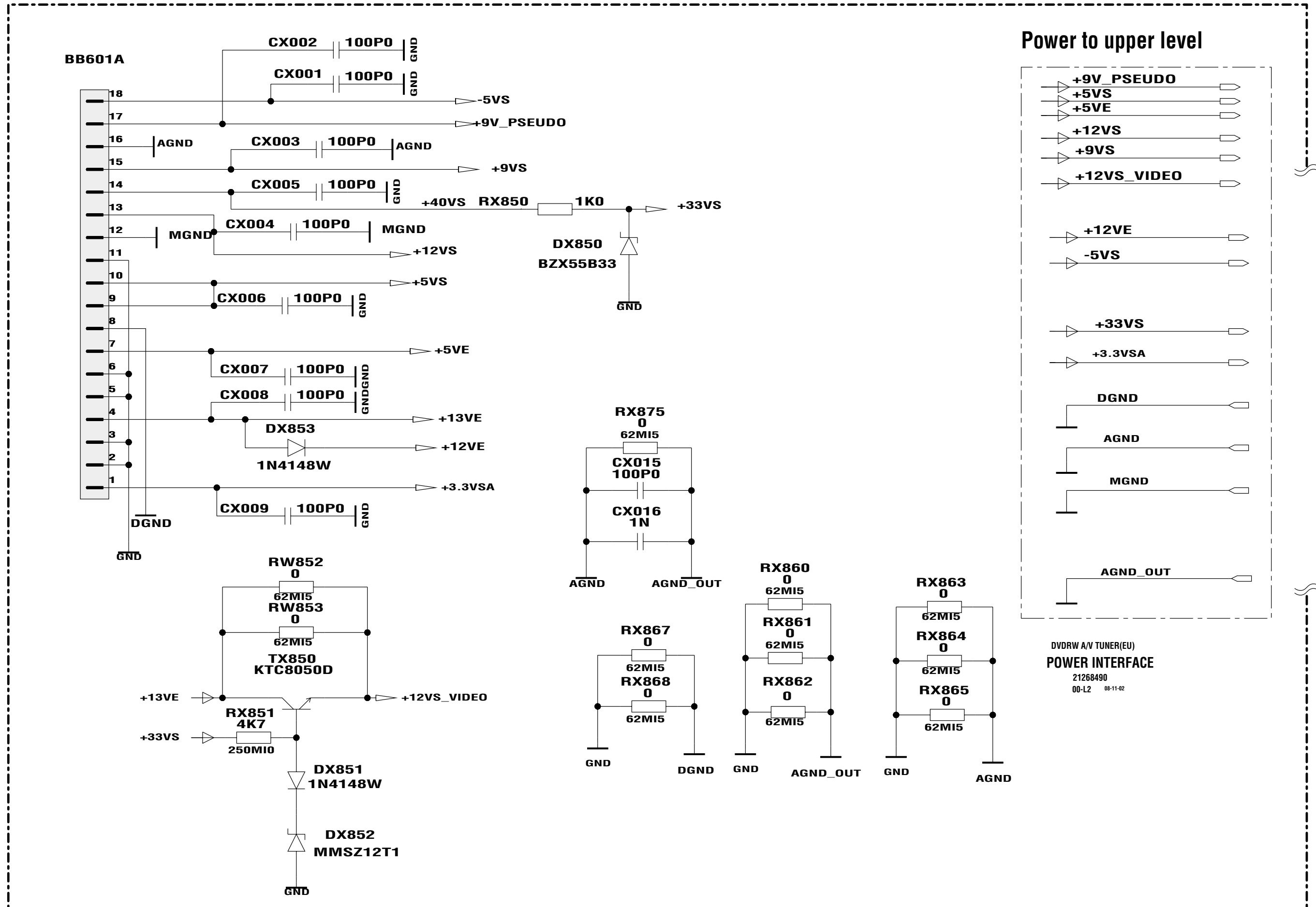
SCART INTERFACE / TUNER SCHEMATIC DIAGRAM - SCHEMA DE L'INTERFACE PERITELEVISION / TUNER - SCHALTBILD EUROPA NORMBUCHSE / TUNER
 SCHEMA DELLA PRESA PERITEL / SINTONIZZATORE - ESQUEMA INTERFAZ EUROTOMA / SINTONIZADOR

(AV TUNER BOARD 9/11)



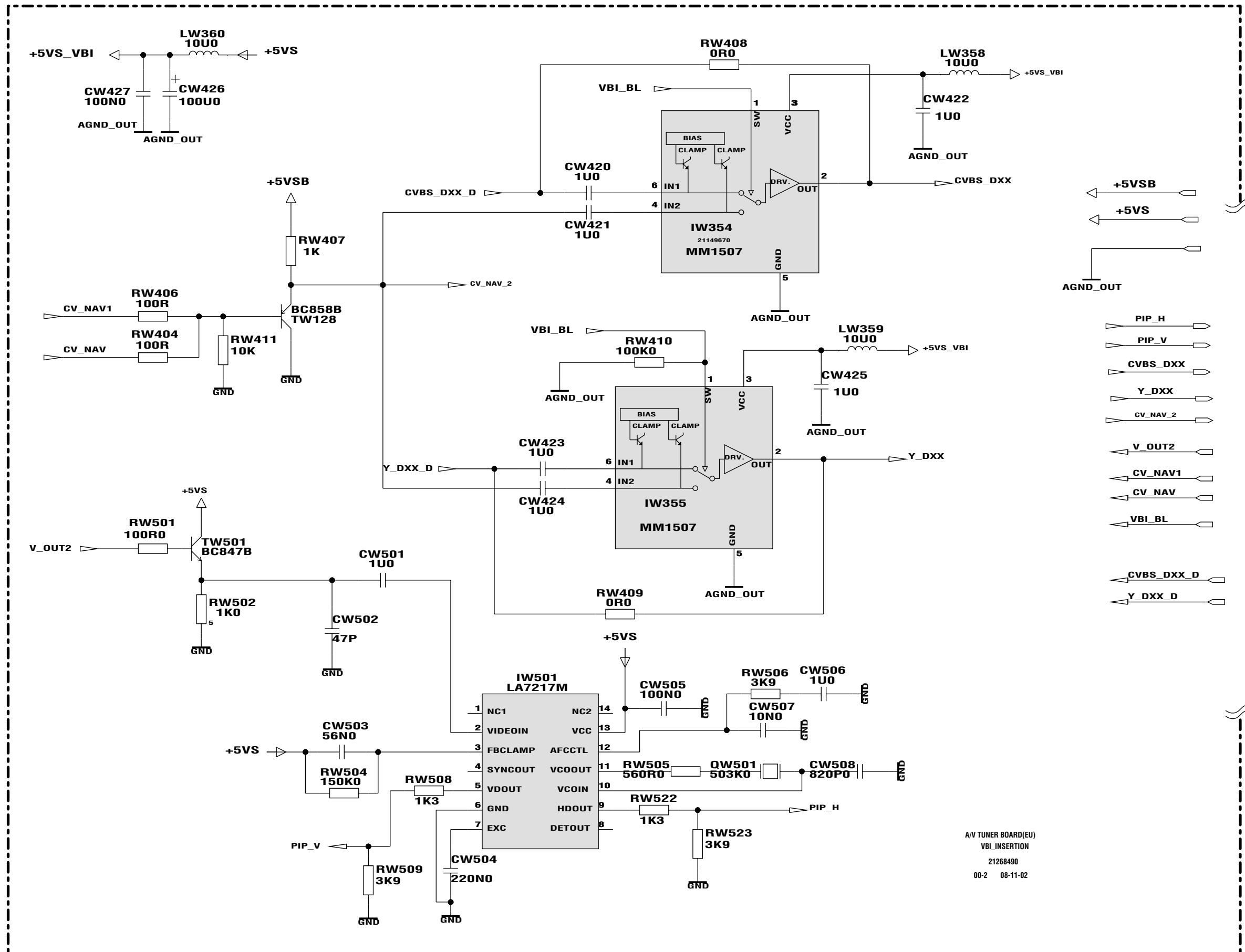
SCART INTERFACE / TUNER SCHEMATIC DIAGRAM - SCHEMA DE L'INTERFACE PERITELEVISION / TUNER - SCHALTBILD EUROPA NORMBUCHSE / TUNER
 SCHEMA DELLA PRESA PERITEL / SINTONIZZATORE - ESQUEMA INTERFAZ EUROTOMA / SINTONIZADOR

(AV TUNER BOARD 10/11)



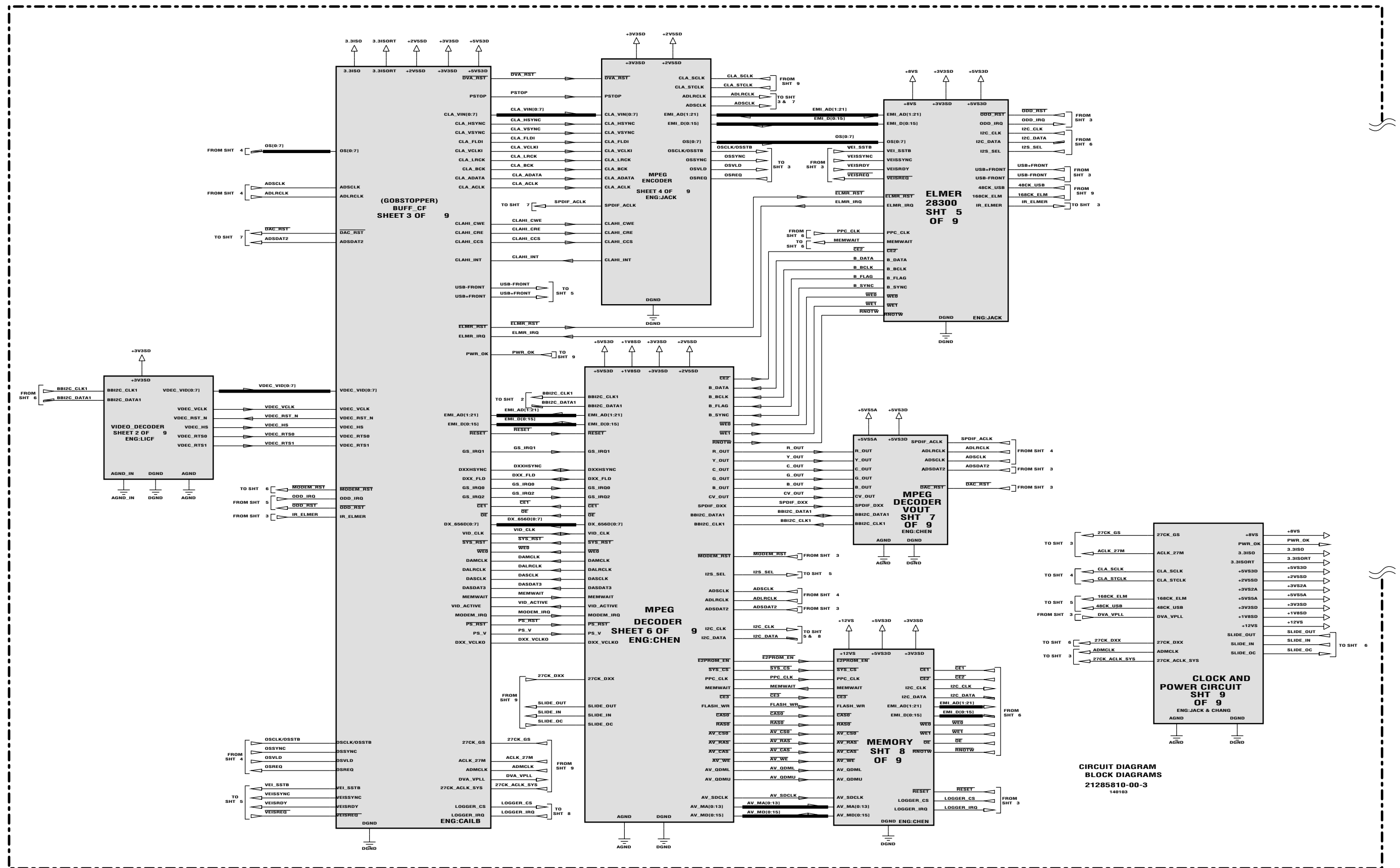
SCART INTERFACE / TUNER SCHEMATIC DIAGRAM - SCHEMA DE L'INTERFACE PERITELEVISION / TUNER - SCHALTBILD EUROPA NORMBUCHSE / TUNER
 SCHEMA DELLA PRESA PERITEL / SINTONIZZATORE - ESQUEMA INTERFAZ EUROTOMA / SINTONIZADOR

(AV TUNER BOARD 11/11)



MAIN SCHEMATIC DIAGRAM - SCHEMA DE LA PLATINE PRINCIPALE - SCHALTBILD HAUPTPLATINE - SCHEMA DELLA PIASTRA PRINCIPALE- ESQUEMA DE LA PLATINA PRINCIPAL

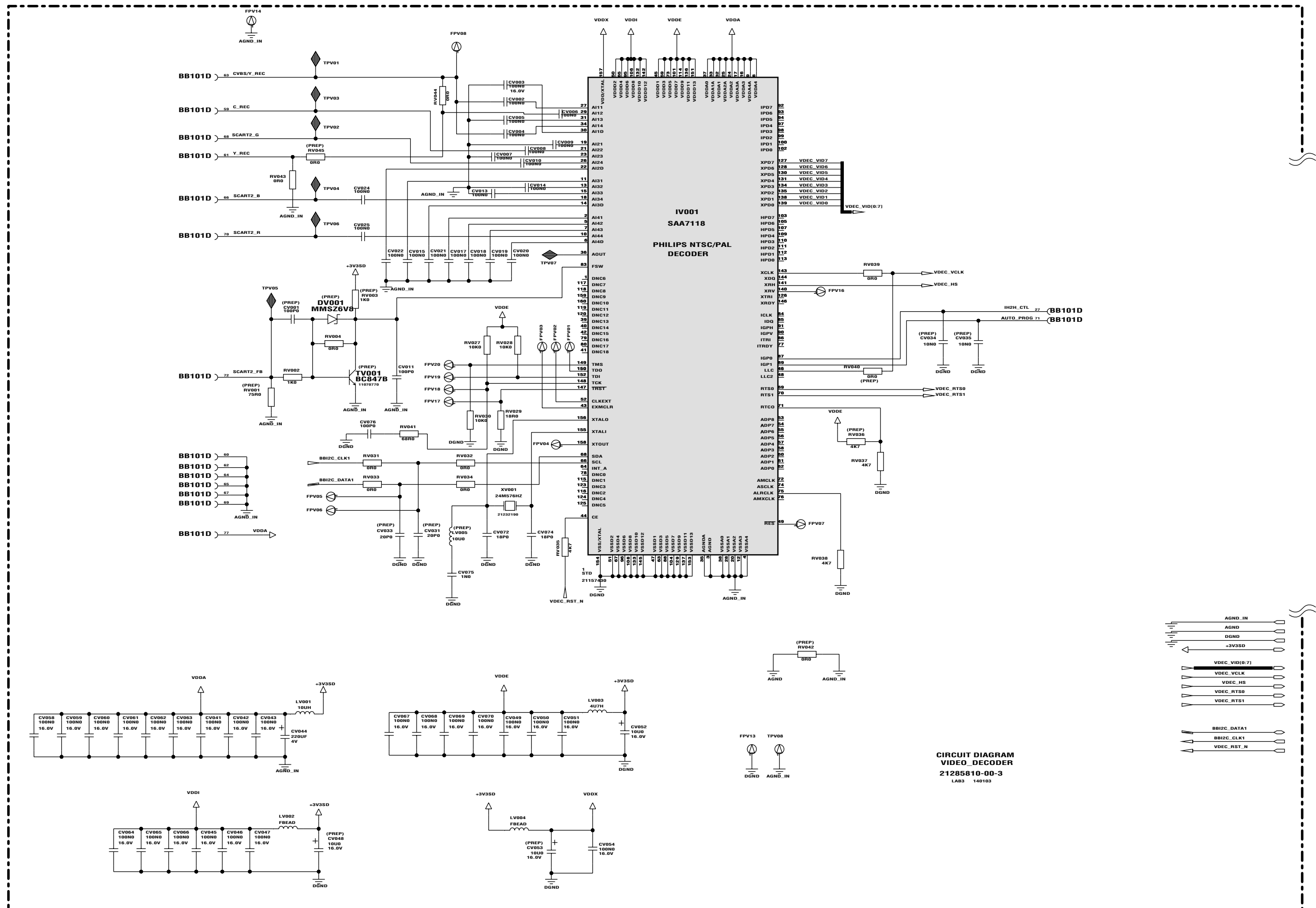
(DIGITAL BOARD 1/9)



CIRCUIT DIAGRAM
BLOCK DIAGRAMS
2128510-00-3
140103

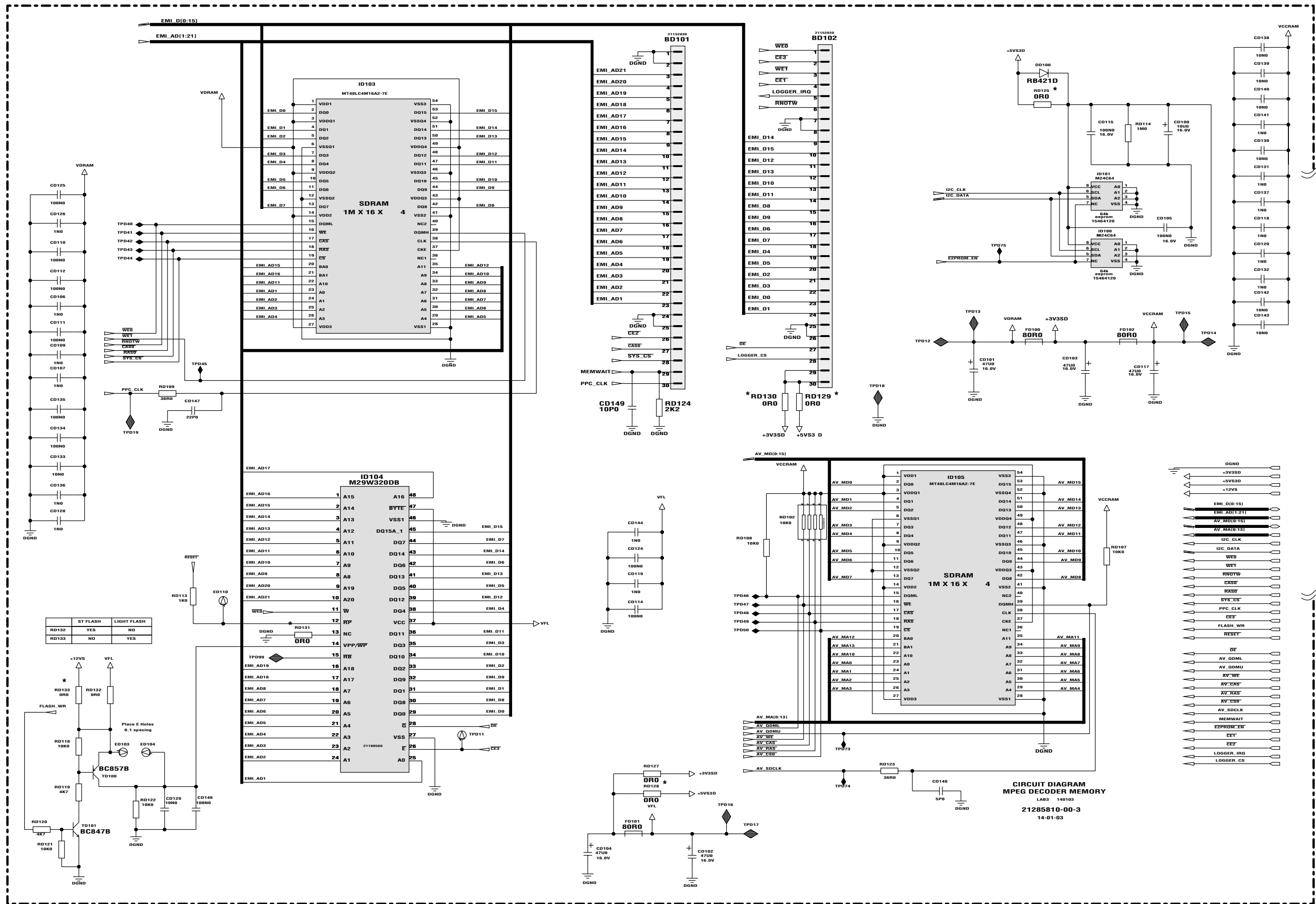
MAIN SCHEMATIC DIAGRAM - SCHEMA DE LA PLATINE PRINCIPALE - SCHALTBILD HAUPTPLATINE - SCHEMA DELLA PIASTRA PRINCIPALE- ESQUEMA DE LA PLATINA PRINCIPAL

(DIGITAL BOARD 2/9)



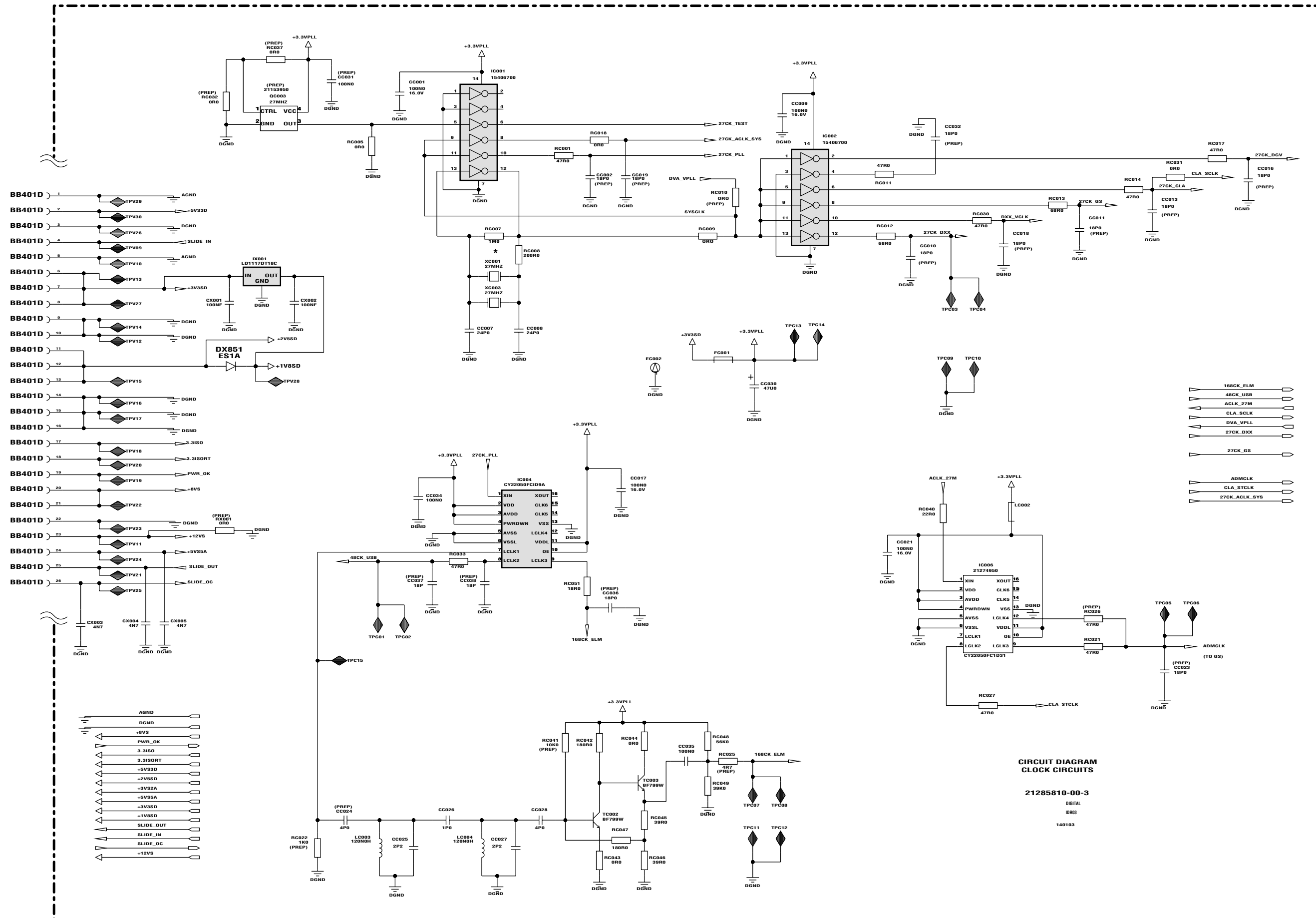
MAIN SCHEMATIC DIAGRAM - SCHEMA DE LA PLATINE PRINCIPALE - SCHALTBILD HAUPTPLATINE - SCHEMA DELLA PIASTRA PRINCIPALE- ESQUEMA DE LA PLATINA PRINCIPAL

(DIGITAL BOARD 8/9)



MAIN SCHEMATIC DIAGRAM - SCHEMA DE LA PLATINE PRINCIPALE - SCHALTBILD HAUPTPLATINE - SCHEMA DELLA PIASTRA PRINCIPALE- ESQUEMA DE LA PLATINA PRINCIPAL

(DIGITAL BOARD 9/9)

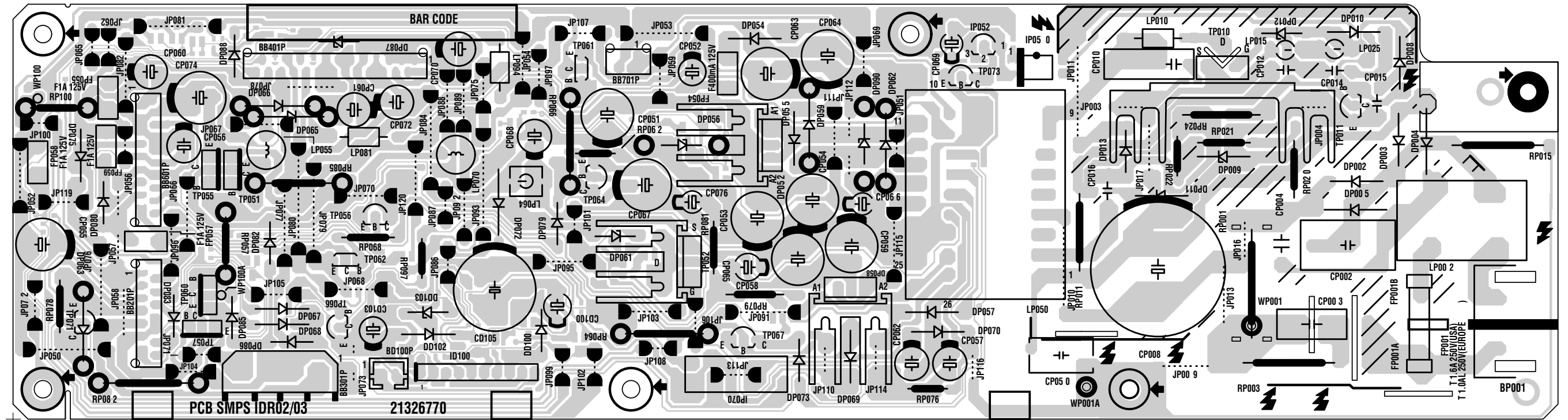


CIRCUIT DIAGRAM
CLOCK CIRCUITS

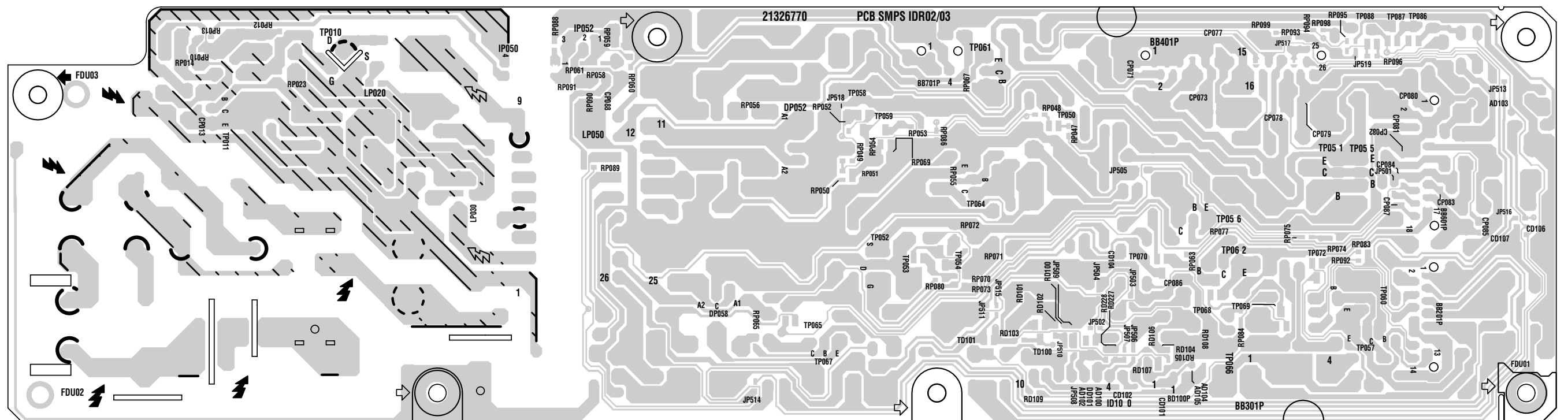
21285810-00-3
DIGITAL
IDR03
140103

POWER SUPPLY CIRCUIT BOARD - CIRCUIT IMPRIME DE L'ALIMENTATION - LEITERPLATTE NETZTEIL - PIASTRA DEI CIRCUITI DI ALIMENTAZIONE - PLATINA ALIMENTACIÓN

COMPONENT SIDE - COTÉ COMPOSANTS - BESTÜCKUNGSSEITE - LATO COMPONENTI - LADO COMPONENTES

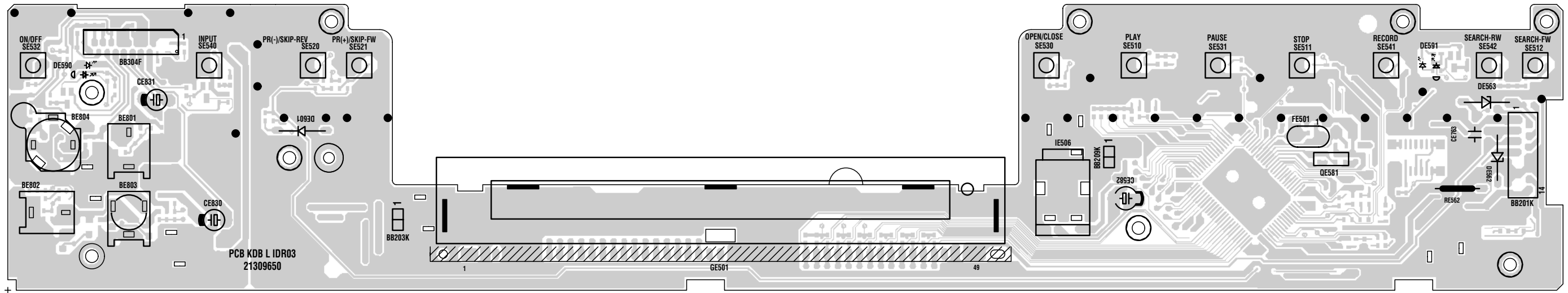


SOLDER SIDE - COTÉ CUIVRE - LÖTSEITE - LATO SALDATURE - LADO DEL COBRE

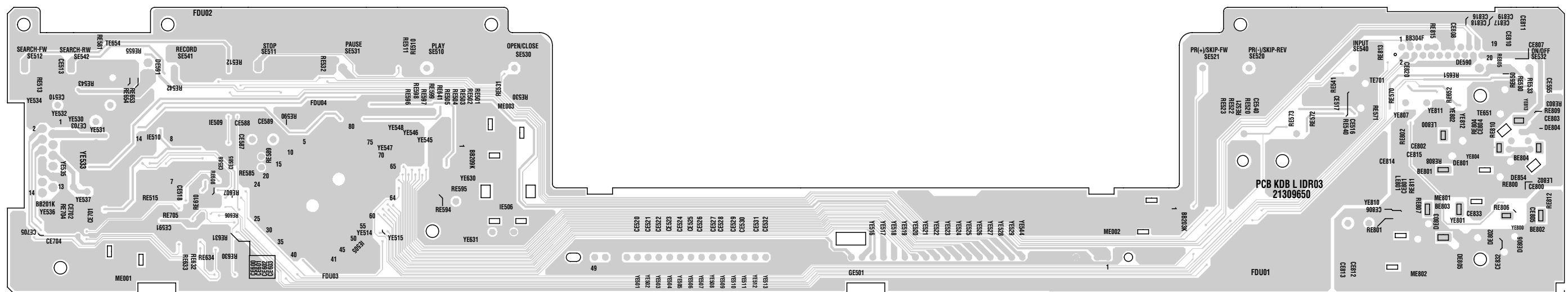


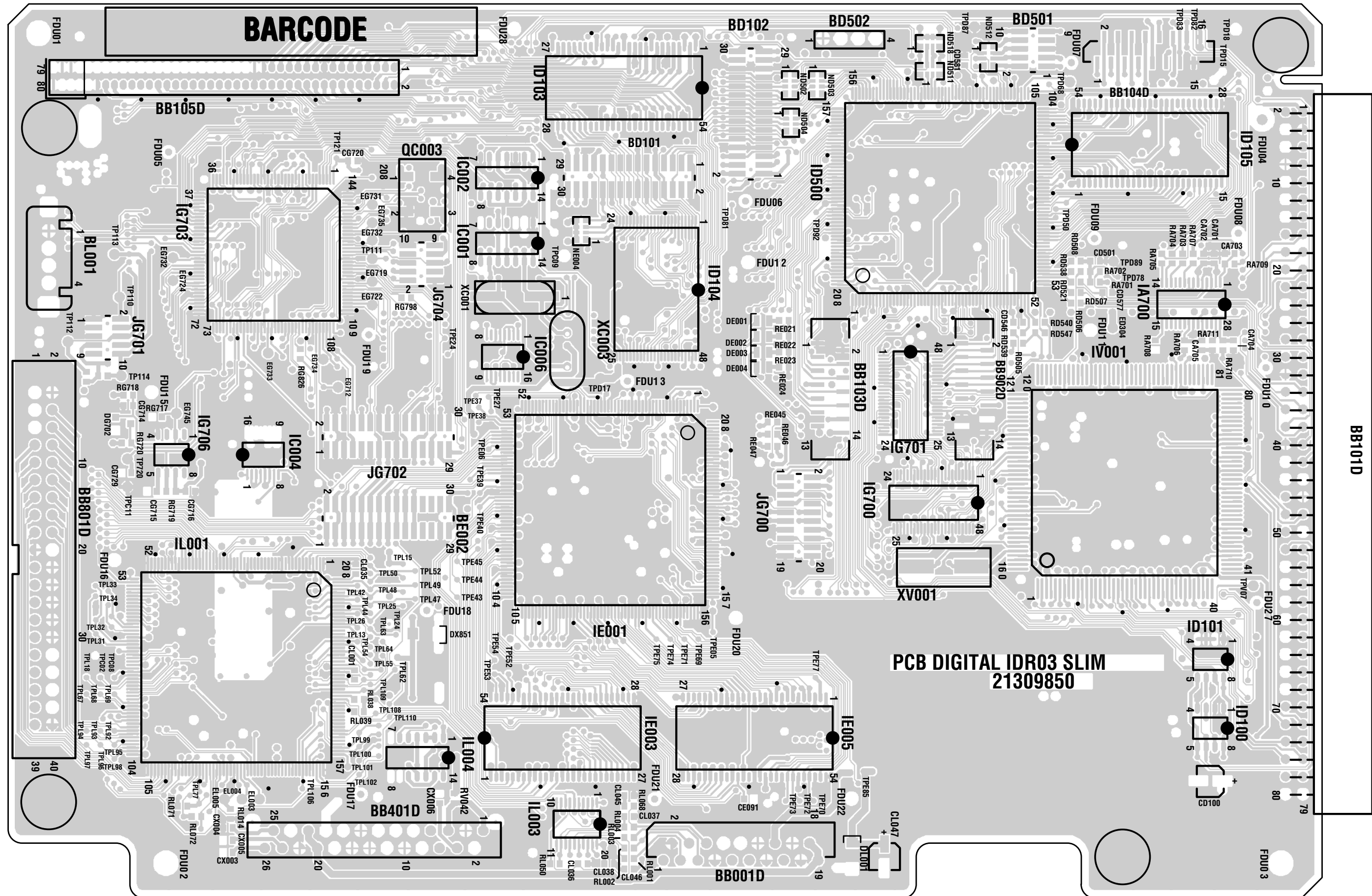
KEYBOARD CIRCUIT BOARDS - CIRCUITS IMPRIMES PLATINES COMMANDES - LEITERPLATTE BEDIENTEIL - PIASTRE TASTIERA - PLATINAS MANDOS

COMPONENT SIDE - COTÉ COMPOSANTS - BESTÜCKUNGSSEITE - LATO COMPONENTI - LADO COMPONENTES



SOLDER SIDE - COTÉ CUIVRE - LÖTSEITE - LATO SALDATURE - LADO DEL COBRE







ABBREVIATIONS - ABBREVIATIONS - ABKÜRZUNGEN - ABBREVIAZIONI - ABBREVIACIONES

AV/TUNER ABBREVIATIONS

16X9_IND 16X9 (or 4X3) format indication
 1H/2H_CTL Component video 1H or 2H selection
 ADLRCLK Audio ADC word clock
 ADSCLK Audio ADC bit clock
 ADSDAT1 Audio ADC 1 data
 ADSDAT2 Audio ADC 2 data
 AGND Audio ground
 AGND_OUT Video output(from DXX) ground
 AUTO_PROG_7118 Auto program control from SAA7118
 AVLINK2 Scart 2 pin 10
 AVLINKIRQ Scart 1 or 2 pin 10 interrupt to
 - TMP87
 B/PB2H_DXX Blue or (PB-2H) signal from DXX
 BBI2C_CLK Slow I2C -CLK (+5V)
 BBI2C_DATA Slow I2C- DATA (+5V)
 BBI2C_DATA1 Slow I2C-DATA (+3.3V)
 C_DXX Chroma signal output from DXX
 C_REC Chroma signal for recording to
 - SAA7118
 C_SYNC Composite-sync (V+ H sync)
 CTR Center channel
 CV/Y_REC CVBS or Luma for recording to
 - SAA7118
 CV_MOVIEBOX CVBS prepare to movie box
 CV_NAV1 CVBS to naviclick module
 CV_OUT2 CVBS to scart 2 output for decoder
 CV_TUNER1 CVBS signal from local AV board
 - Tuner
 CVBS_DXX CCVBS output from DXX to VBI
 - insertion IC
 CVBS_DXX_D CVBS output from DXX
 DAC_MUTE1 Audio mute control for DAC
 DAC_RST Reset control for CS4392 DAC
 DALRCLK Audio DAC word clock
 DAMCLK Audio DAC oversampling clock
 DASCLK Audio DAC bit clock
 DASDAT0 Audio DAC 0 data
 DASDAT1 Audio DAC 1 data
 DASDAT2 Audio DAC 2 data
 DASDAT3 Audio DAC 3 data
 DC_IN Fan detection
 DMX_L Audio Left downmix-channel out
 DMX_R Audio Right downmix-channel out
 DMXL Audio Left downmix-channel out
 DMXR Audio Right downmix-channel out
 EN_ST9 enable ST9
 FAN_ON_DXX Fan On/Off control from DXX
 FPAIRQ Front panel Interrupt
 G/Y2H_DXX Green/Y-2H output from DXX
 H_PIP Horizontal sync for picture in picture
 HW_SW 1H or 2H component video switch
 - control
 I2C_CLK Fast I2C- CLK for Naviclick module
 I2C_DATA Fast I2C- DATA for Naviclick module
 IN1_L Main audio_L source to ADC 1
 IN1_R Main audio_R source to ADC 1
 IN2_L Mixing audio_L source to ADC1
 IN2_R Mixing audio_R source to ADC1
 IN3_L Main audio_L source to ADC 2
 IN3_R Main audio_R source to ADC 2
 IR_SAT T IR- Blaster outout signal
 KDB_RST KDB reset
 MIC_IN_L Mic input Left to Sanyo switching IC
 MIC_IN_R Mic input Right to Sanyo switching IC
 MIC_L Mic input Left to Sanyo switching IC
 MIC_R Mic input Right to Sanyo switching IC
 NICAM_RST Nicam reset
 PB_2H Component videoPb(2H) from
 - Progressive Scan board
 PIP_BL Picture-in picture blanking
 PR_2H T Component video Pr(2H) form
 - Progressive Scan board
 PWM_HPVO PWM headphone volume control
 - signal
 R/PR2H_DXX Red(or Pr-2H) from DXX
 RST_ST9 ST9 reset
 SC3_PIN8_16X9 Pin 8 of 3rd scart control signal

SC3_PIN8_ACT Pin 8 of 3rd scart control signal
 SCART_TV_CV/Y Scart1 video input
 SCART_TV_L Scart 1 audio left output
 SCART_TV_R T Scart 1 audio right output
 SCART_VCR_B B Scart 2 blue signal input
 SCART_VCR_C/R Scart 2 chroma(or Red) signal input
 SCART_VCR_CV/Y Scart 2 video signal output
 SCART_VCR_G Scart 2 green signal input
 SCART_VCR_L Scart 2 audio left input
 SCART_VCR_R Scart 2 audio right input
 SCART2 Scart 2 pin 8 (scale down)
 - to interrupt TMP87
 SCART2_B Scart 2 blue signal output
 SCART2_FB Scart2 pin 16 fast blanking
 SPDIF Sound Pro Digital interface
 ST9_RST_GOB ST9 reset from
 - Gobstopper(prepared)
 TUNER1_L RF audio from tuner1
 TUNER1_R RF audio from tuner1
 TUNER2_L RF audio from tuner 2
 TUNER2_R RF audio from tuner 2
 +12VFAN Fan supply
 3V3DA Supply voltage 3.3V
 AFT1/AVLINK_R T AV Link Read signal
 AMUTE Audio mute control for Cinch output
 AV_LINK1 Scart 1 pin 10
 B_SC3 3rd scart Blue signal output
 B_TV Scart 1 Blue signal output
 C/R_TV Scart 1 chroma(or Red) signal output
 CV/Y_SC3 3rd scart video signal output (pin 19)
 CV_FRONT CVBS signal from Front input
 FB_SC3 3rd scart fast blanking pin 16
 FSTV_OUT Scart 1 fast blanking output
 G_SC3 3rd scart green signal output
 G_TV Scart 1 green signal output
 HP_L Left downmix-channel for
 - headphone
 HP_R Right downmix-channel for
 - headphone
 LF Left front channel
 LOUT_TV Scart 1 audio left output
 LOUT_VCR Scart 2 audio right output
 LS Left surround channel
 PIN8_SC3 3rd scart pin 8
 R/C_SC3 Red(or Chroma) signal output
 RF Right front channel
 ROUT_TV Scart 1 audio right output
 ROUT_VCR Scart 2 audio right output
 RS Right surround channel
 S2_1 Front S_video 16x9 or 4x3
 - detection signal
 SLB_TV Slow blanking output,
 - scart 1 pin 8
 SLB_VCR Slow blanking input, scart 2 pin 8
 ST9_RST_TMP87 ST9 reset signal from TMP87
 SUB Subwoofer
 SV_S3_1 3rd scart CVBS/RGB or
 - S_video select signal
 TUNER_MONO_AUDIO Tuner audio_Mono
 TUNER_SIF Tuner sound IF
 V_1H CVBS 1H output
 V_OUT2 CVBS signal for decoding output
 V_PIP Vertical sync for PIP purpose
 VBI_BL VBI blanking from Gobstopper
 VBI_SEL Video source selecting signal
 - (for Naviclick module)
 VID_DET Video valid signal detection
 Y/CV_TV Scart 1 video signal output
 Y/CV_VCR Scart 2 video signal output
 Y_2H Luma(2H) from progressive
 - scan board
 Y_DXX Luma output form DXX
 - (after VBI insertion)
 Y_DXX_D Luma outpu from DXX
 - (before VBI insertion)
 Y_FRONT Luma input from front pannel
 CV/Y_REC_SEL CVBS or Luma select signal
 - for Recording

DIGITAL BOARD ABBREVIATION

168CK_ELM 168MHz Elmer clock
 27CK_ACLK_SYS 27MHz clock for PLL 12.288MHz
 - generator
 27CK_CLA 27MHz clock for Claudia
 27CK_DGV 27MHz clock for Progressive Scan
 27CK_DXX 27MHz clock for DXX
 27CK_GS 27MHz clock for Gobstopper
 27CK_PLL 27MHz clock for PLL 168MHz generator
 48CK_USB 48KHz clock for USB
 ACLK_27M Audio clock 27 MHz
 ACLKI Audio clock input
 ACLKO Audio clock output
 ADLRCLK Audio ADC word clock
 ADMCLK Audio ADC oversampling clock
 ADSCLK Audio ADC bit clock
 ADSDAT1 Audio ADC 1 data
 ADSDAT2 Audio ADC 2 data
 AGND Audio analog ground
 AUD_ADCNTR1 (prepare for MP3)
 AUD_ADCNTR2 (prepare for MP3)
 AUD_AST (prepare for MP3)
 AUD_CS (prepare for MP3)
 AUD_D1 (prepare for MP3)
 AUD_D2 (prepare for MP3)
 AUD_P10B (prepare for MP3)
 AUD_R/W_N (prepare for MP3)
 AUD_STB (prepare for MP3)
 AUTO_PROG Auto programming
 AV_CAS SMI SDRAM column address select
 AV_CS0 SMI SDRAM chip select
 AV_MA0..15 SMI SDRAM address
 AV_MD0..15 SMI SDRAM data
 AV_QDML SMI SDRAM byte 0 enable
 AV_QDMU SMI SDRAM byte 1 enable
 AV_RAS SMI SDRAM row address select
 AV_SDCLK Clock for SMI SDRAM
 AV_WE SMI SDRAM write enable
 AVDD25PLL (prepare for MP3)
 AVLINK AV link (prepare)
 B_BCLK I2S bit clock
 B_DATA I2S data
 B_FLAG I2S flag
 B_OUT B/2H-Pb output from DXX
 B_PB2H_DXX B/2H-Pb output from low-pass filter
 B_SYNC I2S sync
 BBI2C_CLK1 Second pair of I2C clock
 BBI2C_DATA1 Second pair of I2C data
 BUF_OEN1..4 Buffer 1-4 output enable
 C_DXX Chroma output from low-pass filter
 C_OUT Chroma output from DXX
 C_REC Chroma input to Video decoder
 C_SYNC Composite sync(V+H sync)
 CAS0 Column address select
 CE1 Chip Enable 1
 CE2 Chip Enable 2
 CE3 Chip Enable 3
 CLA_ACLK MPEG Encoder Audio oversampling clock
 CLA_ADAT MPEG Encoder Audio data
 CLA_ADATA MPEG Encoder Audio data
 CLA_BCK MPEG Encoder audio bit clock
 CLA_FLDI MPEG Encoder Flied
 CLA_HSYNC MPEG Encoder horizontal sync
 CLA_LRCK MPEG Encoder Audio word clock
 CLA_SCLK MPEG Encoder Audio bit clock
 CLA_STCLK MPEG Encoder Audio bit clock
 CLA_VCLKI MPEG Encoder Digital video clock in
 CLA_VIN0..7 MPEG Encoder Digital data
 CLA_VSYNC MPEG Encoder vertical sync
 CLAH1_CCS MPEG Encoder chip select
 CLAH1_CRE MPEG Encoder read
 CLAH1_CWAIT MPEG Encoder wait
 CLAH1_CWE MPEG Encoder Write
 CLAH1_INT MPEG Encoder Interrupt
 CLAP0 MPEG Encoder
 CLAUDIA_25V Power supply +2.5V for Claudia
 CLAUDIA_33V Power supply +3.3V for Claudia
 CS1FX Chip select 0
 CS3FX Chip select 1
 CTS (prepare for Modem)
 CV_OUT CVBS from DXX
 CVBS/Y_RE CVBS/Y input to Video decoder
 CVBS_DXX CVBS from low-pass filter

DA0..2 PCM output data 0-2
 DAC_MUTE1 Audio mute control for UDA1338 DAC and ----
 - output cinch
 DAC_RST Audio DAC reset for CS4392
 DALRCLK PCM left/right audio word clock
 DAMCLK Over sampling audio DAC oversamplin clock
 DASCLK Over sampling audio DAC bit clock
 DASDAT0..3 PCM output data audio DAC 0-3 data
 DBBRDY0_1 (prepare for MP3)
 DBBWRDY0_1 (prepare for MP3)
 DCLK serial clock
 DD1 data input
 DGND Digital Ground
 DIOR I/O read
 DIOW I/O write
 DMACK DMA acknowledge
 DMS operation mode
 DRSTZ N-wire reset
 DSR (prepare for Modem)
 DTR (prepare for Modem)
 DVA_ABCK V Link (IEEE1394)
 DVA_ACLKI AV Link (IEEE1394) Audio clock input
 DVA_ACLKO AV Link (IEEE1394) Audio clock output
 DVA_ALRCK AV Link (IEEE1394) Audio left/right clock
 DVA_APLL AV Link (IEEE1394) Audio PLL
 DVA_FLD AV Link (IEEE1394) Field
 DVA_HSYNC AV Link (IEEE1394) H-sync
 DVA_INT0 AV Link (IEEE1394) interrupt 0
 DVA_INT1 AV Link (IEEE1394) interrupt 1
 DVA_PCM AV Link (IEEE1394) PCM
 DVA_RST AV Link (IEEE1394) reset
 DVA_VCLK AV Link (IEEE1394) Video clock
 DVA_VCLKI AV Link (IEEE1394) Video clock input
 DVA_VCLKO AV Link (IEEE1394) Video clock output
 DVA_VD0..7 AV Link (IEEE1394) Video data bus
 DVA_VPLL AV Link (IEEE1394) Video PLL
 DVA_VSYNC AV Link (IEEE1394) V-sync
 DVAPI_CHRDY AV Link (IEEE1394) ch ready
 DVAPI_CS AV Link (IEEE1394) Chip select
 DXX_656D0..7 Digital Video output data from DXX
 DXX_FLD Field signal from DXX
 DXX_GEM_SW Input source select between DXX and
 - Gem for Progressive Scan
 DXX_MOV_SW Input source select between DXX and
 - Movie Board for Progressive Scan (prepare)
 DXX_RST MPEG Decoder Dxx reset
 DXX_VCLK MPEG Decoder Dxx video clock
 DXXHSYNC MPEG Decoder Dxx horizontal sync
 DXXVCC Power supply for DXX
 E2PROM_EN E2PROM enable
 ELMGPIO15 Elmer GPIO port
 ELMR_IRQ Elmer interrupt
 ELMR_RST Elmer reset
 EMI_AD1..21 EMI bus address line
 EMI_D0..15 EMI bus data line
 EN_ST9 ST9 enable
 FAN_ON Fan control
 FLASH_WR Flash write
 FPA_IRQ FPA interrupt
 FS_BK Fast blank
 G_OUT R/2H-Y element output from DXX
 G_Y2H_DXX R/2H-Y element output from low-pass filter
 GEM_FS Gem fast blank
 GOB_TCK Test clock of Gobstopper JTAG
 GOB_TDI Test data in of Gobstopper JTAG
 GOB_TDO Test data out of Gobstopper JTAG
 GOB_TMS Test mode select of Gobstopper JTAG
 GOB_TRSTB Test reset of Gobstopper JTAG
 GS_IRQ0 Gobstopper output interrupt 0
 GS_IRQ1 Gobstopper output interrupt 1
 GS_IRQ2 Gobstopper output interrupt 2
 H_1H H-sync for interlace mode
 H_VBI H-sync for PIP
 HDD_NODD HDD and ODD select
 HW_SW 1H/2H output hardware switch
 I2C_CLK First pair of I2C bus clock
 I2C_DATA First pair of I2C bus data
 I2S_SEL I2S select between Elmer output and ODD ----
 - output
 I2S_SEL_NOT not I2S select between Elmer output and -
 - ODD output
 IDE_D0..15 IDE data
 IDERESET IDE reset
 IH2H_CTL 1H/2H control signal
 INTRQ IDE interrupt
 INTRQ_ODD ODD interrupt
 IORDY IDE IO ready
 IR_ELMER IR blaster signal generated by Elmer
 IR_GOB IR blaster signal generated by Gobstopper
 - (prepare)
 IR_SAT IR blaster signal for satellite decoder
 IS0..7 input stream Data for MPEG encoder

ISCLK/ISSTBinput stream clock for MPEG encoder	SDRAMRASEMI SDRAM row address select
ISSYNCinput stream sync for MPEG encoder	SDRD0..15EMI SDRAM data
ISVLDInput stream	SLIDE_INODD tray close control signal
KDB_RSTKDB reset	SLIDE_OCODD tray over-current detection
LOGGER_CSLogger Test Board chip select	SLIDE_OUTODD tray open control signal
LOGGER_IRQLogger Test Board interrupt	SPDIFSound Pro Digital Interface
MCAS_Claudia SDRAM column address select	SPDIF_DXXSPDIF output from DXX
MCKEClaudia SDRAM clock enable	SYS_CSBank0 (EMI SDRAM) chip select
MCLKClaudia SDRAM clock	SYS_RSTSystem reset
MCS_Claudia SDRAM chip select	SYSCLKSystem clock
MDQMHClaudia SDRAM byte 1 enable	TCKTest clock of DXX JTAG
MDQMClaudia SDRAM byte 0 enable	TDITest data in of DXX JTAG
MEMWAITMememory wait	TDOTest data out of DXX JTAG
MODEM_IRQModem Interrupt (perpare)	TMSTest mode select of DXX JTAG
MODEM_RSTModem Reset (perpare)	TRESETTest reset of DXX JTAG
MRASClaudia SDRAM row address select	TRIG_INTrigger in
MWEClaudia SDRAM write enable	TRIG_OUTTrigger out
NICAM_RSTNicam Reset	TX_ELMTrasmit Elmer
ODD_IRQODD Interrupt	TXD1Transmit data 1
ODD_RSTODD Reset	TXD2Transmit data 2
OEOutput enable	USB+FRONTUSB input +
OS0..7Output stream Data signal	USB-FRONTUSB input -
OSCLK/OSSTBOutput stream clock signal	V_1HV-sync for interlace mode
OSREQOutput stream request signal	V_VBIV-sync for PIP (picture in picture)
OSSYNCOutput stream sync signal	-function
OSVLDOutput stream valid signal	VBI_BLPIP blanking
OVHSYNCOutput stream H-sync signal	VCCRAMVCC for EMI SDRAM and SMI SDRAM
OVVSYNCOutput stream V-sync signal	VCLKIVideo clock input
PDIAGIDE Diaquostic pin	VCLKOVideo clock output
PGNDPLL ground	VDDAAnalog supply voltage for analog inputs
PPC_CLKClock for EMI SDRAM	VDDEDigital supply voltage (peripheral cells)
PS_RSTProgressive Scan reset	VDDIDigital supply voltage 2 (core)
PS_VV-sync for Progressive Scan	VDDXSupply voltage for crystal oscillator
PSTOPPart of reset for MPEG encoder	VDEC_HSVideo decoder H-sync output
PVDD22.5V power supply for PLL	VDEC_RST_NVideo decoder reset
PWR_OKPower ok	VDEC_RTS0Video decoder real time status output
R_OUTR/2H-Pr ouput from DXX	VDEC_RTS1Video decoder real time status output
R_PR2H_DXXR/2H-Pr ouput from low-pass filter	VDEC_VCLKVideo decoder clock output
RAS0Row address select 0	VDEC_VID0..7Video decoder video data output
RESETReset	VDRAMPower supply +3.3V for SMI SDRAM and
RING(prepare for Modem)	-EMI SDRAM
RLSD(prepare for Modem)	VEI_SSTBVEIS Strobe
RNOTWRead nor write	VEISRDYVEIS Ready
RTS(prepare for Modem)	VEISREQVEIS Request
RX_ELMReceive Elmer	VEISSYNCVEIS Ready
RXD1Receive data 1	VFLPower supply +3.3V for Flash
RXD2Receive data 2	VID_ACTIVEVideo active
SDRA0..11EMI SDRAM address	VID_CLKVideo clock
SDRADQMHEMI SDRAM byte 1 enable	VID_DETVideo detect
SDRADQMLEMI SDRAM byte 0 enable	WE0Write enable 0
SDRAM_WEEMI SDRAM write enable	WE1Write enable 1
SDRAMBA0EMI SDRAM bank select	Y_DXXY output from low-pass filter
SDRAMCS0EMI SDRAM column address select	Y_OUTY output from DXX

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